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THICK-FILM CHIP RESISTOR





We, Samsung, declare that our component Chip Resistor is produced in accordance with EU RoHS directive.

1. RoHS Compliance and restriction of Br

The following restricted materials are not used in packaging materials as well as products in compliance with the law and restriction.

- Cd, Pb, Hg, Cr+6, As, Br and the compounds, PCB, asbestos
- Bromic materials : PBBs, PBBOs, PBDO, PBDE, PBB

2. No use of materials breaking Ozone layer

The following ODS materials are not used in our fabrication process.

- ODS material : Freon, Haron, 1-1-1 TCE, CCl4, HCFC

If you want more detailed Information, Please Visit Samsung Electro-mechanics Website
[<http://www.sem.samsung.com>, <http://www.semlcr.com>]

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Applications

- Chip resistors are designed for general electronic devices such as home appliances, computer, mobile communications, digital circuit, etc. If you require our products with high reliability-performing at more than 125℃ or below -55℃- for medical equipments, aircrafts, high speed machines, military usage, and items that can affect human life or if you need to use in specific conditions (corrosive gas atmosphere like H₂S etc.), please contact us beforehand.
- Normal operation temperature ranges (℃): -55℃~+155℃
- Others (rectangular, array_Flat type, trimmable) : -55℃~+125℃
- Although resistor body is coated, sharp excessive impact should be avoided to prevent damages and adverse effects on characteristics (resistor value, open circuited, T.C.R.).

Mounting

Please give more attention not to press the chip owing to the nozzle's improper height when it is mounted on PCB.
(Excessive pressure may cause exterior damage, change in resistance, circuit open, etc.)

Safety precautions

- These products are designed and produced for applying to the ordinary electronic equipments.
(AV equipment, OA equipment,Telecommunication equipment, etc)
- Consult with our sales department before applying in the devices that require extremely high reliability such as medical equipments, transport equipments, aircrafts/ spacecrafts, nuclear power controllers, fuel controllers, car equipments including car accessories and other safety devices.
- Following special environments, and such environmental conditions may affect the performance of the product. Please verify the performance and reliability thoroughly prior to use.
 - a) Using in various type of Liquid including water, oil, organic solvent and other chemicals.
 - b) Using in the places where the products are exposed to direct sunlight, sea wind, corrosive gases (including Cl₂, H₂S, NH₃, SO₂, NO₂), static electricity, electromagnetic waves and dusty air.
 - c) Using close to heat generating components or other flammable items.
 - d) Using in the places that is sealed or coated with resins or other coating materials after soldering.
 - e) Using in places subject to dew condensation.
- These products are not radiation resistant.
- The company is not responsible for any problems resulting from using of the products under the conditions not recommended herein.
- The company should notify any safety issues of the products to the customer. And the safety of the products should be monitored by the customer periodically.

Storage

- To maintain proper quality of chip components, the following precautions are required for storage environment, method and period.
- Storage Environment
 - Make sure that the ambient temperature is within 5℃~40℃ and the ambient humidity is within 20~70%RH.
 - Chip components may be deformed, if the temperature of packaged components exceeds 40℃.
 - Do not store where the soldering properties can be deteriorated by harmful gas such as sulphurous gas, chlorine gas, etc.
 - Bulk packed chip components should be used as soon as the seal is opened, thus preventing the solderability from deteriorating.
 - The remaining unused chips should be put in the original bag and sealed again or store in a desiccator containing a desiccating agent.
 - Storage Time Period
 - Stored chip components should be used within 6 months after receiving the components. If 6 months or more have elapsed, please check the solderability before actually using.

Cleaning

After Soldering Cleaning, soldering flux & Ionic cleaning liquid should be avoided on product.
If any possibility on product, please take a test before usage.

Caution for Chip Resistor Separation from PCB.

Chip resistor installation on PCB is a similar phenomenon on to a chocolate chip on top of a cake.
PCB has enough flexibility on outer force but Chip resistor can be defected without any bending.
(By chip resistor use of Ceramic, solder, metal)
Therefore, when separating a Chip resistor from a PCB, beware of any crack on the chip.

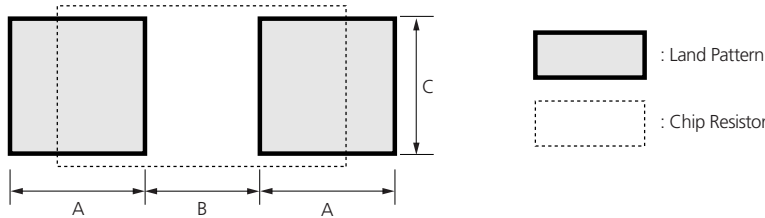
Others

- Manual work
 - Whenever separating chip resistor from PCB, do not re-use the chip resistor for circuit safety.
 - Electrical specification of chip resistors can be changed by soldering iron after separation.
 - Re-use of separated chip resistor should be prohibited.
- Do not use more than rated voltage.
(Please check the contents of each product)

Example of Land Pattern Design

- When designing P.C.B, the shape and size of the solder lands must allow a proper amount of solder to form under the resistor.
The amount of solder formed at the end terminations has direct effect on the possibility of chip crack.
The more the amount of solder and stress, the more the possibilities of chip crack.

For Chip Type



• Reflow soldering (UNIT: mm)					• Reflow soldering(RU,RUW,RUK) (UNIT: mm)					• Flow soldering (UNIT: mm)				
Type	A	B	2A+B	C	Type	A	B	2A+B	C	Type	A	B	2A+B	C
0402	0.17	0.20	0.54	0.18	1005	0.8	0.5	2.1	0.5	1005	0.7	0.5	1.9	0.5
0603	0.37	0.28	1.02	0.29	1608	0.8	0.5	2.1	0.8	1608	0.9	0.8	2.6	0.8
1005	0.6	0.5	1.7	0.5	2012	0.9	0.8	2.6	1.2	2012	1.0	1.4	3.4	1.3
1608	0.8	0.8	2.4	0.8	3216	1.7	1.2	4.6	1.4	3216	1.4	1.8	4.6	1.6
2012	0.9	1.4	3.2	1.2	3225	1.7	1.2	4.6	2.6	3225	1.4	1.8	4.6	2.6
3216	1.3	1.8	4.4	1.5	5025	2.15	1.8	6.1	2.6	5025	1.5	3.3	6.3	2.5
3225	1.3	1.8	4.4	2.4	6432	2.3	3.0	7.6	3.3	6432	1.5	4.6	7.6	3.2
5025	1.4	3.3	6.1	2.4										
6432	1.4	4.6	7.4	3.0										

For Array Type

• Convex type								• Concave type							
(UNIT: mm)								(UNIT: mm)							
Type	A	B	C	D	E	P ₁	P ₂	Type	A	B	C	D	E	P	
062P	0.20	0.20	0.30	0.30	0.30	0.6	-	102P	0.3	0.3	0.2	0.5	0.4	0.5	
064P	0.20	0.20	0.20	0.30	0.30	0.5	0.5	104P	0.3	0.3	0.2	0.5	0.4	0.5	
10AT	0.4	0.4	0.25	0.5	0.5	0.65	-								
102P	0.4	0.4	0.25	0.5	0.5	0.65									
104P	0.7	0.3	0.2	0.5	0.5	0.55									
164P	0.7	0.5	0.3	0.9	0.8	0.9	0.8								

- This is the recommended land pattern for designing PCB.
This pattern does not guarantee any characteristic of other product.

The specifications and designs contained herein may be subject to change without notice.
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Operation Notes

Example of land Pattern Design

Recommended Soldering Conditions

General Structure

General

Precision

Jumper

Low ohms (RUT Series)

Ultra Low ohms (RU Series)

Ultra Low Ohms (RUK Series)

Ultra Low Ohms (RJ Series)

Arrays (CONVEX Type)

Arrays (CONCAVE Type)

Arrays (FLAT Type)

Anti-Sulfur Resistors

Attenuator

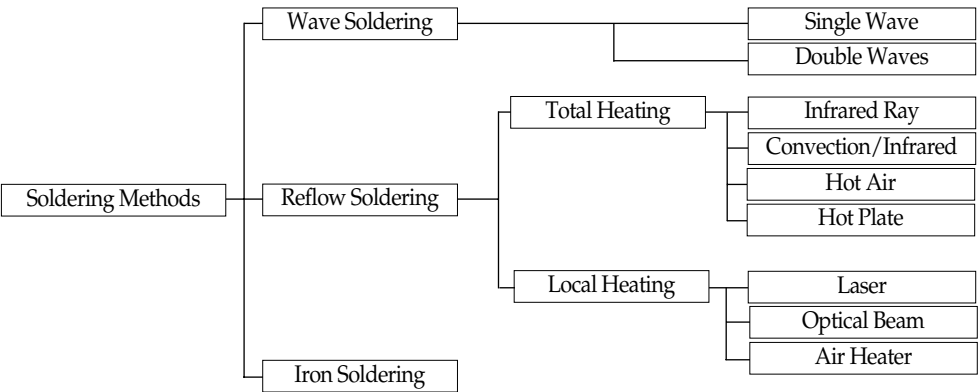
Characteristics Performance

Packaging

Standard Resistance Value

Abstract

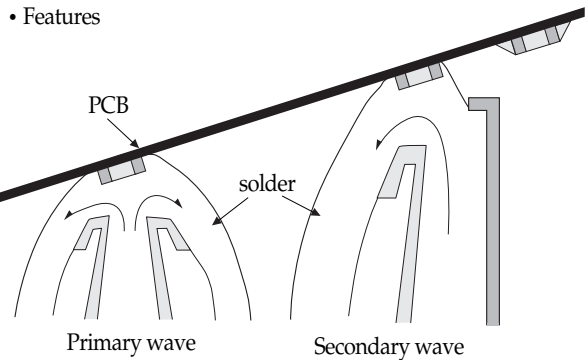
- There are 3 soldering methods.
 - Flow(wave) soldering.
 - Reflow soldering. (Reflow soldering is broadly divided into the total heating method and local heating method.)
 - Iron soldering.



Since Chip resistors come into direct contact with melted solder during soldering, it is exposed to potential mechanical stress caused by the sudden temperature change. The chip resistors may also be subject to silver migration and flux contamination.

Flow(wave) Soldering

- Features



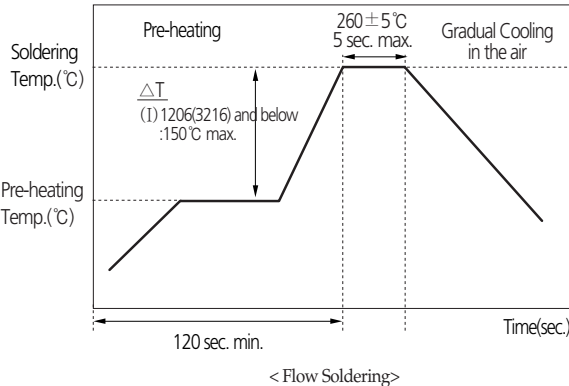
There are two types of soldering methods in flow(wave) soldering. One is single wave soldering, and the other is a double waves soldering. However, double waves soldering is mainly used. This method is designed for continuous and multiple dipping process by using primary and secondary wave, having completely different waveforms and characteristics. With the primary wave, a comparatively strong jet flow is used to remove the flux gas and to solder. With the secondary wave, it is used to remove excessive solder. With the primary wave, the solder flows into a very small gap between components and air bubbles remaining on the soldered joint are removed. With the secondary wave, the peel back is used to prevent bridging.

- Preheating

If a chip component is heated suddenly during soldering, it may crack by the thermal shock caused by the temperature difference between the surface and the inside of the chip. To prevent this, a full preheating is necessary. In case of wave soldering, the temperature difference between solder and surface of the component should be kept within 150℃. Also when cooling is done by dipping into solvent, care should be taken to keep the temperature difference within 150℃.

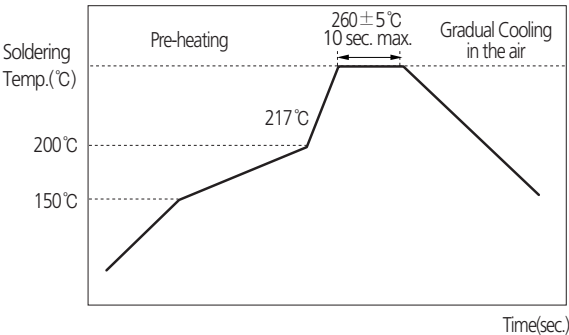
- Standard Soldering Condition

Soldering must be carried out without exceeding the approved soldering temperature and time shown within the shaded area of the graph at right. An excessively long soldering time or high soldering temperature results in leaching of outer terminations. When a PCB is warped, mechanical stress applied to the chip will be increased and might cause chip crack, especially if there is a big amount of solder on the chip. So, care should be taken not to use excessive amount of solder on the PCB. For the flow(wave) soldering, the solder amount can be controlled by land size.



Reflow Soldering

- Pre-heating and cooling
In the reflow soldering method, a full pre-heating at the proper temperature is necessary to dry and activate solder paste. Tomb-stoning can be reduced by preheating at 150~180℃ for more than 1 minute. Also when cooling is done by dipping into solvent, care should be taken to keep the temperature difference within 150℃.



- Standard Reflow Soldering Condition

Soldering must be carried out without exceeding the approved soldering temperature and time shown within the shaded area of the right graph. This prevents the terminations from leaching and characteristics from deteriorating. When soldering is repeated, the allowed time is the accumulated time.

- Standard solder amount

When a PCB is warped, mechanical stress applied to the chip should be reduced, and to do so, care should be taken not to use excessive amount of solder on the PCB. In the case of the reflow method, the thickness of the coated solder paste is controlled to prevent excessive solder. The thickness of solder paste should be 100~300μm.

- Tombstoning and Prevention

When reflow soldering, or especially vapor phase soldering (VPS), small chip components of less than RC3216 type may break away from solder and stand on end. This is commonly known as tombstoning or the Manhattan phenomenon.

- Preventing tombstoning

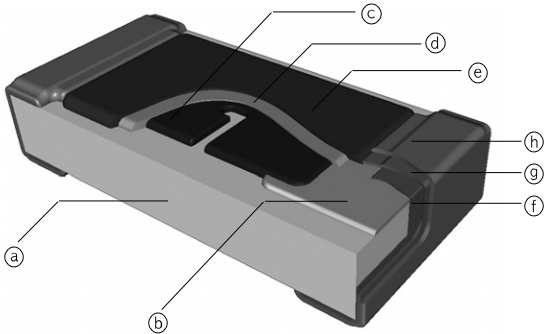
Keep land size as small as possible.
Keep the pre-heating conditions properly
(Pre-heating temperature : 150 ~ 180°, Pre-heating time : more than 1 min.)
Keep the solder paste quantity not too much and uniform for every lands.
Keep the position of chips properly.
At around the soldering temperature, keep minimum difference of the temperature between the electrodes of a chip.

Iron Soldering

When using a soldering iron or any other soldering operation, the permissible temperature and time should not exceed that of the reflow soldering. In order to prevent the external terminations from leaching and characteristics from deteriorating, the tip of the soldering iron should not touch the chip component (ceramic element, resin case, etc.). Soldering with a soldering iron and correcting with a soldering iron can be performed right under following conditions.

Item	Condition
Temperature at tip	350℃ Max.
Soldering iron output	20-Watt Max.
End of soldering iron	ø3mm Max.
Note	Do not directly touch the chip by the tip of the iron.

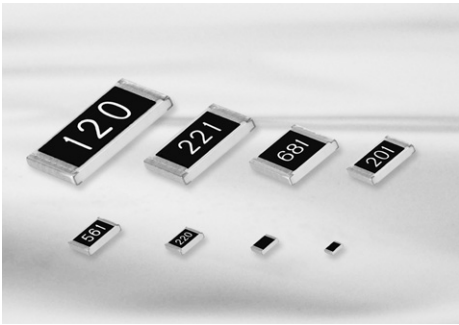
General Structure of the Chip Resistor



No.	Name	Main Substance
(a)	Ceramic Substrate	Al ₂ O ₃
(b)	Inner Electrode	Ag
(c)	Resistor	RuO ₂
(d)	Glass Coat	Bi ₂ O ₃ , SiO ₂
(e)	Protective Coat	Polymer / Glass
(f)	Terminal Coat	Ni-Cr Alloy /Ag
(g)	Ni Plate	Ni
(h)	Sn Plate	Sn

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Operation Notes
Example of land Pattern Design
Recommended Soldering Conditions
General Structure
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Anti-Sulfur Resistors
Attenuator
Characteristics Performance
Packaging
Standard Resistance Value



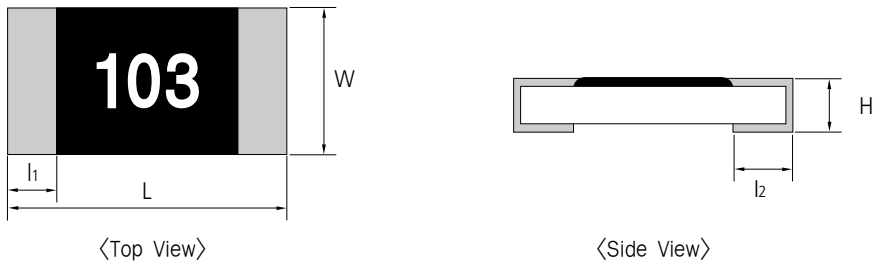
Feature

- Very small, thin, and light weight.
- Both flow and reflow soldering are applicable.
- Very low inductance.
- Suitable size and packaging for surface mount assembly.
- Lead-free terminal.
- PbO(lead oxide) is included in the glass of our product which is prescribed on RoHS appendix as an exemption.

Application

- General purpose.
- Home Appliances.
(DVD, Digital TV, Digital Camera, Audio, Tunner).
- For Computers & Communications.
(Notebook, Memory Module, Mobile, Network Equipment, etc).

Structure and Dimensions



Type	Inch	L	W	H	l ₁	l ₂	Average Weight
RC0402	01005	0.40±0.02	0.20±0.02	0.13±0.02	0.10±0.03	0.10±0.03	0.04mg
RC0603	0201	0.60±0.03	0.30±0.03	0.23±0.03	0.10±0.05	0.15±0.05	0.15mg
RC1005	0402	1.00±0.05	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10	0.6mg
RC1608	0603	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.20	0.35±0.10	2.1mg
RC2012	0805	2.00±0.15	1.25±0.15	0.50±0.10	0.40±0.20	0.35±0.20	4.9mg
RC3216	1206	3.20±0.15	1.60±0.15	0.55±0.10	0.45±0.20	0.40±0.20	9.5mg
RC3225	1210	3.20±0.20	2.55±0.20	0.55±0.10	0.45±0.20	0.40±0.20	16mg
RC5025	2010	5.00±0.20	2.50±0.20	0.55±0.10	0.60±0.20	0.60±0.20	26mg
RC6432	2512	6.30±0.20	3.20±0.20	0.55±0.10	0.60±0.20	0.60±0.20	41mg

Parts Numbering System

RC	2012	J	100	CS
Code Designation	Dimension & Size Code	Tolerance	Resistance Value	Packaging Code
RC : Chip Resistor	0402: 0.4 × 0.2(mm) - 01005(inch)	F : ±1% G : ±2% J : ±5% K : ±10%	3 or 4 digits coding system (IEC coding system) 3digits (E-24 series) 4digits (E-96 series)	GS: Bulk Packaging CS: Tape Packaging 7" ES: Tape Packaging 10" AS: Tape Packaging 13"
	0603: 0.6 × 0.3(mm) - 0201(inch)			
	1005: 1.0 × 0.5(mm) - 0402(inch)			
	1608: 1.6 × 0.8(mm) - 0603(inch)			
	2012: 2.0 × 1.2(mm) - 0805(inch)			
	3216: 3.2 × 1.6(mm) - 1206(inch)			
	3225: 3.2 × 2.5(mm) - 1210(inch)			
	5025: 5.0 × 2.5(mm) - 2010(inch)			
	6432: 6.4 × 3.2(mm) - 2512(inch)			

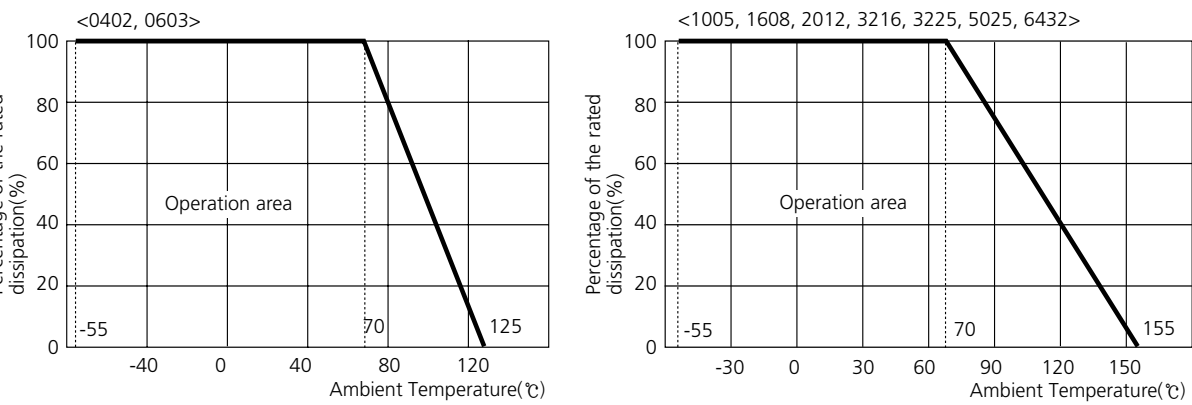
Specification

Type	Power Rating (W)	Working Voltage (MAX)	Overload Voltage (MAX)	TCR (ppm/℃)	Resistance Range (Ω)	Rated Ambient Temperature	Rated Working Temperature
RC 0402	1/32	15(V)	30(V)	1~99 Ω : ±300 100~1 MΩ : ±250	1 Ω ~1 MΩ	70℃	-55℃~+125℃
RC 0603	1/20	25(V)	50(V)	1~9.9 Ω : +300,-200 10 Ω ~1 MΩ : ±100 (0603 : ±250) 1.1 MΩ ~10 MΩ : ±300	1 Ω ~10 MΩ		-55℃~+155℃
RC 1005	1/16	50(V)	100(V)				
RC 1608	1/10						
RC 2012	1/8						
RC 3216	1/4						
RC 3225	1/3	200(V)	400(V)				
RC 5025	2/3						
RC 6432	1						

• Rated voltage (V) = $\sqrt{\text{Rated power(W)} \times \text{Nominal resistance value } (\Omega)}$
Rated voltage should be lower than (MAX) working voltage.

Power Derating Curve

The rated power is the maximum continuous loading power at 70°C ambient temperature.
For ambient temperature above 70°C, the loading power follows the below power derating curve.
(The load current shall be derated according to derating curve in case of the 'Jumper')



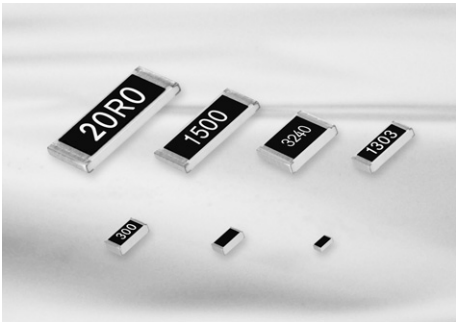
Marking

• 3 digits indication (E-24 series)	• 4 digits indication (E-96 series)
- Left 2 digits represent significant figures. - Last 1 digit represents exponential number of 10. - Example: 103 - Left 2 digits: 10 - Last 1 digit: 3 $103 = 10 \times 10^3 \Omega = 10000 \Omega = 10k\Omega$	- Left 3 digits represent significant figures. - Last 1 digit represents exponential number of 10. - Example: 1002 - Left 3 digits: 100 - Last 1 digit: 2 $1002 = 100 \times 10^2 \Omega = 10000 \Omega = 10k\Omega$
• 0603, 1005 type: No marking.	• 0603, 1005, 1608 type: No marking.

IEC Code System (E-96, E-24)

E-96	E-24	E-96	E-24	E-96	E-24	E-96	E-24
100	10	178	18	316	33	562	56
102		182		324		576	
105		187		332		590	
107		191		340		604	
110	11	196		348		619	
113		200	20	357	36	634	62
115		205		365		649	
118		210		374		665	
121	12	215		383	39	681	68
124		221	22	392		698	
127		226		402		715	
130	13	232		412		732	
133		237		422		750	75
137		243	24	432	43	768	
140		249		442		787	
143		255		453		806	
147		261		464		825	82
150	15	267		475	47	845	
154		274	27	487		866	
158		280		499		887	
162	16	287		511	51	909	
165		294		523		931	91
169		301	30	536		953	
174		309		549		976	

- Operation Notes
- Example of land Pattern Design
- Recommended Soldering Conditions
- General Structure
- General
- Precision
- Jumper
- Low ohms (RUT Series)
- Ultra Low ohms (RU Series)
- Ultra Low Ohms (RUK Series)
- Ultra Low Ohms (RJ Series)
- Arrays (CONVEX Type)
- Arrays (CONCAVE Type)
- Arrays (FLAT Type)
- Anti-Sulfur Resistors
- Attenuator
- Characteristics Performance
- Packaging
- Standard Resistance Value



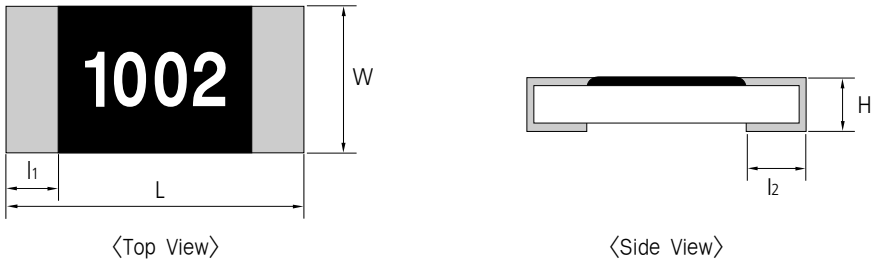
Feature

- Low tolerance (±0.5%).
- Both flow and reflow soldering are applicable.
- Suitable size and packaging for surface mount assembly.
- Very low inductance.
- Lead-free terminal.
- PbO(lead oxide) is included in the glass of our product which is prescribed on RoHS appendix as an exemption.

Application

- Circuit for high precision resistance and reliability.
- For signal control part.
- For tuning circuit.

Structure and Dimensions



Type	Inch	L	W	H	l ₁	l ₂	Average Weight
RC1005	0402	1.00±0.05	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10	0.6mg
RC1608	0603	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.20	0.35±0.10	2.1mg
RC2012	0805	2.00±0.15	1.25±0.15	0.50±0.10	0.40±0.20	0.35±0.20	4.9mg
RC3216	1206	3.20±0.15	1.60±0.15	0.55±0.10	0.45±0.20	0.40±0.20	9.5mg
RC3225	1210	3.20±0.20	2.55±0.20	0.55±0.10	0.45±0.20	0.40±0.20	16mg
RC5025	2010	5.00±0.20	2.50±0.20	0.55±0.10	0.60±0.20	0.60±0.20	26mg
RC6432	2512	6.30±0.20	3.20±0.20	0.55±0.10	0.60±0.20	0.60±0.20	41mg

Parts Numbering System

RC	1005	D	1002	CS
Code Designation	Dimension & Size Code	Tolerance	Resistance Value	Packaging Code
RC : Chip Resistor	1005: 1.0×0.5(mm) - 0402(inch) 1608: 1.6×0.8(mm) - 0603(inch) 2012: 2.0×1.2(mm) - 0805(inch) 3216: 3.2×1.6(mm) - 1206(inch) 3225: 3.2×2.5(mm) - 1210(inch) 5025: 5.0×2.5(mm) - 2010(inch) 6432: 6.4×3.2(mm) - 2512(inch)	D : ±0.5%	3 or 4 digits coding system (IEC coding system) 3digits (E-24 series) 4digits (E-96 , E-192 series)	GS: Bulk Packaging CS: Tape Packaging 7" ES: Tape Packaging 10" AS: Tape Packaging 13"

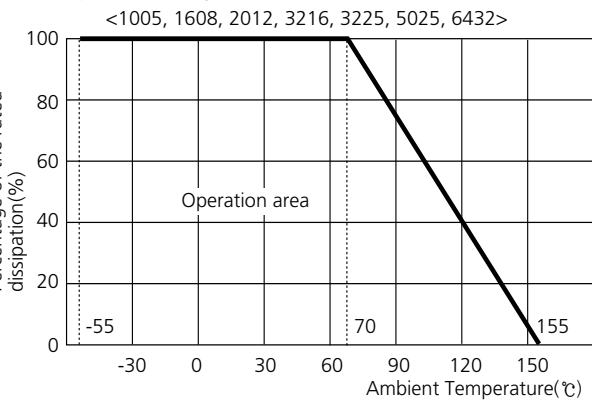
Specification

Type	Power Rating (W)	Working Voltage (MAX)	Overload Voltage (MAX)	TCR (ppm/℃)	Resistance Range (Ω)	Rated Ambient Temperature	Rated Working Temperature
RC 1005	1/16	50(V)	100(V)	1~9.9Ω :±300 10Ω~1 MΩ :±100 1.1 MΩ~10 MΩ :±300	1 Ω~10 MΩ	70℃	-55℃~-+155℃
RC 1608	1/10		300(V)				
RC 2012	1/8	150(V)					
RC 3216	1/4	200(V)	400(V)				
RC 3225	1/3						
RC 5025	2/3						
RC 6432	1						

• Rated voltage (V) = $\sqrt{\text{Rated power(W)} \times \text{Nominal resistance value } (\Omega)}$
Rated voltage should be lower than (MAX) working voltage.

Power Derating Curve

The rated power is the maximum continuous loading power at 70℃ ambient temperature.
For ambient temperature above 70℃, the loading power follows the below power derating curve.



Marking

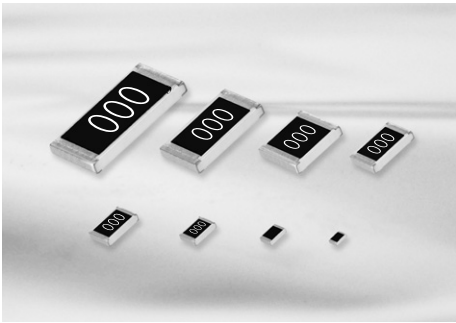
• 3 digits indication (E-24 series)	• 4 digits indication (E-96 , E-192 series)
- Left 2 digits represent significant figures. - Last 1 digit represents exponential number of 10. - Example: 103 Left 2 digits: 10 Last 1 digit: 3 $103 = 10 \times 10^3 \Omega = 10000 \Omega = 10k\Omega$	- Left 3 digits represent significant figures. - Last 1 digit represents exponential number of 10. - Example: 1002 Left 3 digits: 100 Last 1 digit: 2 $1002 = 100 \times 10^2 \Omega = 10000 \Omega = 10k\Omega$
• 1005 type: No marking.	• 1005, 1608 type: No marking.

Significant Figure of Resistance Value

E192	E96	E24	E192	E96	E24	E192	E96	E24	E192	E96	E24	E192	E96	E24	E192	E96	E24	E192	E96	E24
100	100	10	133	133		178	178		237	237		316	316		422	422		562	562	56
101			135			180		18	240		24	320			427			569		75
102	102		137	137		182	182		243	243		324	324		432	432	43	576	576	768
104			138			184			246			328			437			583		777
105	105		140	140		187	187		249	249		332	332	33	442	442		590	590	787
106			142			189			252			336			448			597		796
107	107		143	143		191	191		255	255		340	340		453	453		604	604	806
109			145			193			258			344			459			612		816
110	110	11	147	147		196	196		261	261		348	348		464	464		619	619	825
111			149			198			264			352			470		47	626		835
113	113		150	150	15	200	200	20	267	267		357	357		475	475		634	634	845
114			152			203			271		27	361		36	481			642		856
115	115		154	154		205	205		274	274		365	365		487	487		649	649	866
117			156			208			277			370			493			657		876
118	118		158	158		210	210		280	280		374	374		499	499		665	665	887
120		12	160		16	213			284			379			505			673		898
121	121		162	162		215	215		287	287		383	383		511	511	51	681	681	909
123			164			218			291			388			517			690		920
124	124		165	165		221	221	22	294	294		392	392	39	523	523		698	698	931
126			167			223			298			397			530			706		942
127	127		169	169		226	226		301	301	30	402	402		536	536		715	715	953
129			172			229			305			407			542			723		965
130	130	13	174	174		232	232		309	309		412	412		549	549		732	732	976
132			176			234			312			417			556			741		988

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Please contact our sales representatives or product engineers before order.

- Operation Notes
- Example of land Pattern Design
- Recommended Soldering Conditions
- General Structure
- General
- Precision
- Jumper
- Low ohms (RUT Series)
- Ultra Low ohms (RU Series)
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- Characteristics Performance
- Packaging
- Standard Resistance Value



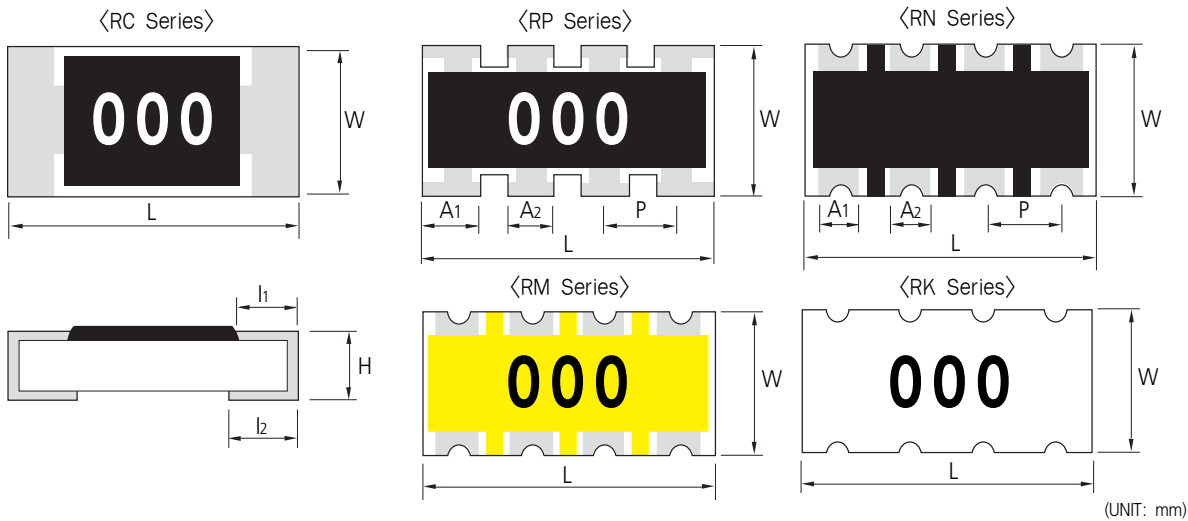
Feature

- Very small, thin, and light weight.
- Both flow and reflow soldering are applicable.
- Very low inductance.
- Suitable size and packaging for surface mount assembly.
- 100 % Lead-free product(Except RP series).

Application

- General purpose.
- Home Appliances.
(DVD, Digital TV, Digital Camera, Audio, Tunner).
- For Computers & Communications.
(Notebook, Memory Module, Mobile, Network Equipment, etc).

Structure and Dimensions



Type	Inch	L	W	H	A ₁	A ₂	I ₁	I ₂	P	Average Weight
RC0402	01005	0.40±0.02	0.20±0.02	0.13±0.02	-	-	0.10±0.03	0.10±0.03	-	0.04mg
RC0603	0201	0.60±0.03	0.30±0.03	0.23±0.03	-	-	0.10±0.05	0.15±0.05	-	0.15mg
RC1005	0402	1.00±0.05	0.50±0.05	0.35±0.05	-	-	0.20±0.10	0.25±0.10	-	0.6mg
RC1608	0603	1.60±0.10	0.80±0.10	0.45±0.10	-	-	0.30±0.20	0.35±0.10	-	2.1mg
RC2012	0805	2.00±0.15	1.25±0.15	0.50±0.10	-	-	0.40±0.20	0.35±0.20	-	4.9mg
RC3216	1206	3.20±0.15	1.60±0.15	0.55±0.10	-	-	0.45±0.20	0.40±0.20	-	9.5mg
RC3225	1210	3.20±0.20	2.55±0.20	0.55±0.10	-	-	0.45±0.20	0.40±0.20	-	16mg
RC5025	2010	5.00±0.20	2.50±0.20	0.55±0.10	-	-	0.60±0.20	0.60±0.20	-	26mg
RC6432	2512	6.30±0.20	3.20±0.20	0.55±0.10	-	-	0.60±0.20	0.60±0.20	-	41mg
RP102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.33±0.10	-	0.20±0.10	0.25±0.10	0.65±0.10	1.1mg
RP104P	0402x4R	2.00±0.10	1.00±0.10	0.35±0.10	0.40±0.15	0.30±0.15	0.15±0.10	0.25±0.10	0.50±0.15	2.2mg
RP164P	0603x4R	3.20±0.10	1.60±0.10	0.50±0.10	0.60±0.15	0.40±0.15	0.30±0.15	0.30±0.15	0.80±0.15	8.9mg
RN102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.30±0.10	-	0.15±0.10	0.25±0.15	0.50±0.10	1.2mg
RN104P	0402x4R	2.00±0.10	1.00±0.10	0.40±0.10	0.30±0.10	0.30±0.10	0.15±0.10	0.25±0.15	0.50±0.10	2.8mg
RM102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.30±0.10	-	0.15±0.10	0.25±0.15	0.50±0.10	1.2mg
RM104P	0402x4R	2.00±0.10	1.00±0.10	0.45±0.10	0.30±0.10	0.30±0.10	0.15±0.10	0.25±0.15	0.50±0.10	2.8mg
RK102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.30±0.10	-	-	0.25±0.15	0.50±0.10	1.2mg
RK104P	0402x4R	2.00±0.10	1.00±0.10	0.45±0.10	0.30±0.10	0.30±0.10	-	0.25±0.15	0.50±0.10	2.8mg
RF062P	0201x2R	0.80±0.05	0.60±0.05	0.23±0.10	0.20±0.10	-	0.10±0.10	0.20±0.10	0.50±0.05	0.3mg
RF064P	0201x4R	1.40±0.05	0.60±0.05	0.23±0.10	0.20±0.10	0.20±0.10	0.10±0.10	0.20±0.10	0.40±0.05	0.5mg
RM062P	0201x2R	0.80±0.05	0.60±0.05	0.23±0.10	0.20±0.10	-	0.10±0.10	0.20±0.10	0.50±0.05	0.3mg
RM064P	0201x4R	1.40±0.05	0.60±0.05	0.23±0.10	0.20±0.10	0.20±0.10	0.10±0.10	0.20±0.10	0.40±0.05	0.5mg

Parts Numbering System

- The part number system shall be in the following format

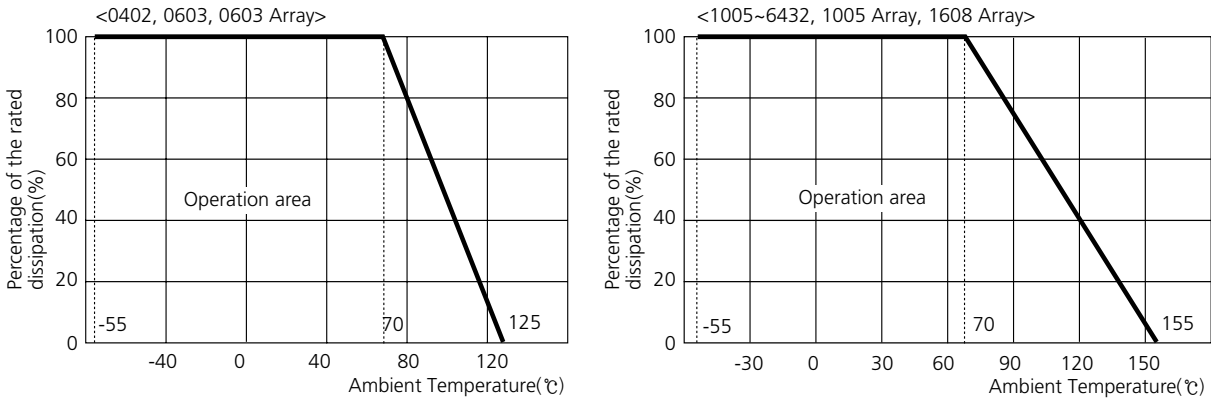
R C	2 0 1 2	J	0 0 0	CS
Code Designation	Dimension & Size Code	Tolerance	Resistance Value	Packaging Code
R C : General	0402: 0.4 × 0.2(mm) - 01005(inch) 0603: 0.6 × 0.3(mm) - 0201(inch) 1005: 1.0 × 0.5(mm) - 0402(inch) 1608: 1.6 × 0.8(mm) - 0603(inch) 2012: 2.0 × 1.2(mm) - 0805(inch) 3216: 3.2 × 1.6(mm) - 1206(inch) 3225: 3.2 × 2.5(mm) - 1210(inch) 5025: 5.0 × 2.5(mm) - 2010(inch) 6432: 6.4 × 3.2(mm) - 2512(inch)	J : Max 50 mΩ	Jumper: 000	GS: Bulk Packing CS: Tape & Reel 7" ES: Tape & Reel 10" AS: Tape & Reel 13"
R P : Convex Array	102P: 1.0 × 1.0(mm) - 0404(inch) 104P: 2.0 × 1.0(mm) - 0804(inch) 164P: 3.2 × 1.6(mm) - 1206(inch)			
R N : Concave Array				
R M : Inverted Array				
R K : Inverted Short-free Array				
R F : Flat Array				

Jumper Resistors

Type	Resistance	Current Rating	Rated Ambient Temperature	Rated Working Temperature	Marking
RC0402	50mΩ max	0.5 (A)	70℃	-55℃ ~ +125℃	X
RC0603					X
RC1005					X
RC1608					X
RC2012	50mΩ max	2.0 (A)	70℃	-55℃ ~ +155℃	O
RC3216					O
RC3225					O
RC5025					O
RC6432	50mΩ max	1.0 (A)	70℃	-55℃ ~ +155℃	X
RP102P					O
RP104P					O
RP164P					O
RN102P	50mΩ max	1.0 (A)	70℃	-55℃ ~ +155℃	X
RN104P	50mΩ max	1.0 (A)	70℃	-55℃ ~ +155℃	X
RM102P	50mΩ max	1.0 (A)	70℃	-55℃ ~ +155℃	O
RM104P	50mΩ max	1.0 (A)	70℃	-55℃ ~ +155℃	O
RK102P	50mΩ max	1.0 (A)	70℃	-55℃ ~ +155℃	X
RK104P	50mΩ max	1.0 (A)	70℃	-55℃ ~ +155℃	O
RF062P	50mΩ max	0.5 (A)	70℃	-55℃ ~ +125℃	X
RF064P					X
RM062P					X
RM064P					X

Power Derating Curve

The rated power is the maximum continuous loading power at 70℃ ambient temperature.
For ambient temperature above 70℃, the loading power follows the below power derating curve.
(The load current shall be derated according to derating curve in case of the 'Jumper')



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Operation
Notes

Example of land
Pattern Design

Recommended
Soldering Conditions

General Structure

General

Precision

Jumper

Low ohms
(RUT Series)

Ultra Low ohms
(RU Series)

Ultra Low Ohms
(RUK Series)

Ultra Low Ohms
(RJ Series)

Arrays
(CONVEX Type)

Arrays
(CONCAVE Type)

Arrays
(FLAT Type)

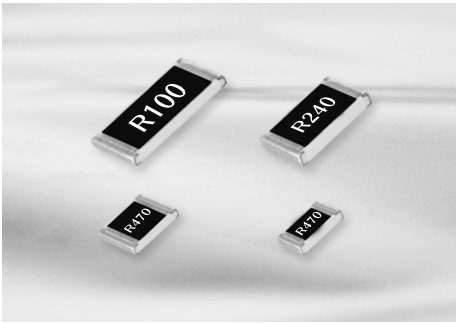
Anti-Sulfur
Resistors

Attenuator

Characteristics
Performance

Packaging

Standard
Resistance Value



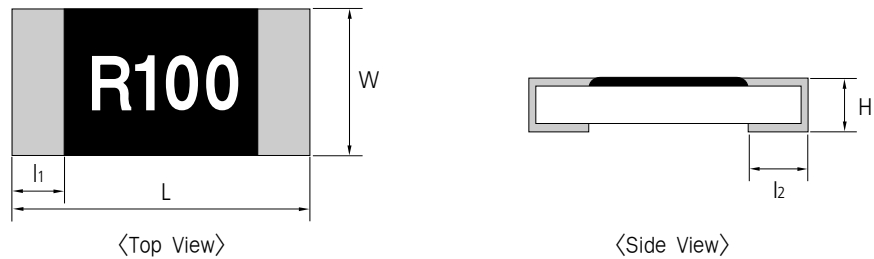
Feature

- Under 1 ohms, precision resistance.
- Both flow and reflow soldering are applicable.
- High Power with Low TCR.
- 100% Lead Free Products (PbO not used).
- RoHS Compliant.

Application

- Current Sensing.
- PCM of Battery Pack.
- Power supplying part, DC power charger, adapter.
- Mobile Phone, HDD, DSC, LCD.

Structure and Dimensions



(UNIT: mm)

Type	Inch	L	W	H	l ₁	l ₂	Average Weight
RUT1005	0402	1.00±0.05	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10	0.6mg
RUT1608	0603	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.20	0.35±0.10	2.1mg
RUT2012	0805	2.00±0.15	1.25±0.15	0.50±0.10	0.40±0.20	0.35±0.20	4.9mg
RUT3216	1206	3.20±0.15	1.60±0.15	0.55±0.10	0.45±0.20	0.40±0.20	9.5mg
RUT3225	1210	3.20±0.20	2.55±0.20	0.55±0.10	0.45±0.20	0.40±0.20	16mg
RUT5025	2010	5.00±0.20	2.50±0.20	0.55±0.10	0.60±0.20	0.60±0.20	26mg
RUT6432	2512	6.30±0.20	3.20±0.20	0.55±0.10	0.60±0.20	0.60±0.20	41mg

Parts Numbering System

- The part number system shall be in the following format

RUT	2012	J	R100	CS
Code Designation	Dimension & Size Code	Tolerance	Resistance Value	Packaging Code
RUT: Current Sensing Resistor Top Mounting (Face-up)	1005: 1.0×0.5(mm) - 0402(inch) 1608: 1.6×0.8(mm) - 0603(inch) 2012: 2.0×1.2(mm) - 0805(inch) 3216: 3.2×1.6(mm) - 1206(inch) 3225: 3.2×2.5(mm) - 1210(inch) 5025: 5.0×2.5(mm) - 2010(inch) 6432: 6.4×3.2(mm) - 2512(inch)	F: ±1% G: ±2% J: ±5%	4-digit coding system	CS: Tape & Reel 7" ES: Tape & Reel 10" AS: Tape & Reel 13"

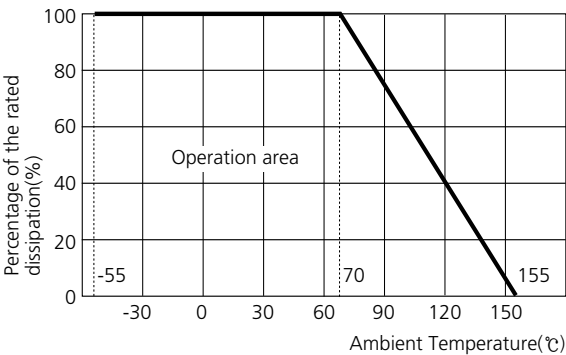
Specification

Type	Power Rating (W)	Working Current (A, MAX)	TCR (ppm/℃)	Resistance Range (Ω)	Rated Ambient Temperature	Rated Working Temperature
RUT1005	1/10 (0.1)	$\sqrt{P/R}$	±150	0.1~0.98	70℃	-55~+155℃
RUT1608	1/8 (0.125)					
RUT2012	1/4 (0.25)					
RUT3216	1/3 (0.33)					
RUT3225	1/2 (0.50)					
RUT5025	2/3 (0.66)					
RUT6432	1 (1.0)					

- Rated Current (A) = $\sqrt{\text{Rated power(W)}/\text{Nominal resistance value (Ω)}}$
Rated Current should be lower than (MAX) working Current.

Power Derating Curve

The rated power is the maximum continuous loading power at 70℃ ambient temperature. For ambient temperature above 70℃, the loading power follows the below power derating curve.



Marking

4 digits indication

- R means decimal point.
- Other digits represent the significant value.
- Example : R100
R100 = .100 = 0.100 Ω
= 0.1 Ω or 100 mΩ

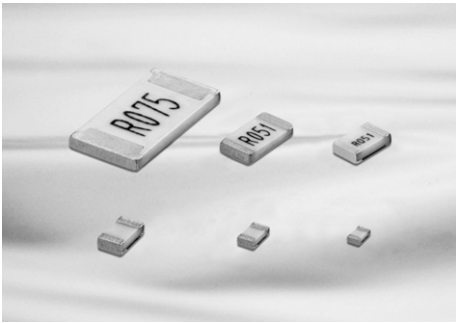


Resistance Value Table

Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)
R100	0.1	±1, ±5	R154	0.154	±1	R226	0.226	±1	R330	0.33	±1, ±5	R470	0.47	±1, ±5	R680	0.68	±1, ±5
R102	0.102	±1	R158	0.158	±1	R232	0.232	±1	R332	0.332	±1	R475	0.475	±1	R681	0.681	±1
R105	0.105	±1	R160	0.16	±1, ±5	R237	0.237	±1	R340	0.34	±1	R487	0.487	±1	R698	0.698	±1
R107	0.107	±1	R162	0.162	±1	R240	0.24	±1, ±5	R348	0.348	±1	R499	0.499	±1	R715	0.715	±1
R110	0.11	±1, ±5	R165	0.165	±1	R243	0.243	±1	R357	0.357	±1	R510	0.51	±1, ±5	R732	0.732	±1
R113	0.113	±1	R169	0.169	±1	R249	0.249	±1	R360	0.36	±1, ±5	R511	0.511	±1	R750	0.75	±1, ±5
R115	0.115	±1	R174	0.174	±1	R255	0.255	±1	R365	0.365	±1	R523	0.523	±1	R768	0.768	±1
R118	0.118	±1	R178	0.178	±1	R261	0.261	±1	R374	0.374	±1	R536	0.536	±1	R787	0.787	±1
R120	0.12	±1, ±5	R180	0.180	±1, ±5	R267	0.267	±1	R383	0.383	±1	R549	0.549	±1	R806	0.806	±1
R121	0.121	±1	R182	0.182	±1	R270	0.27	±1, ±5	R390	0.39	±1, ±5	R560	0.56	±1, ±5	R820	0.82	±1, ±5
R124	0.124	±1	R187	0.187	±1	R274	0.274	±1	R392	0.392	±1	R562	0.562	±1	R825	0.825	±1
R127	0.127	±1	R191	0.191	±1	R280	0.28	±1	R402	0.402	±1	R576	0.576	±1	R845	0.845	±1
R130	0.13	±1, ±5	R196	0.196	±1	R287	0.287	±1	R412	0.412	±1	R590	0.59	±1	R866	0.866	±1
R133	0.133	±1	R200	0.200	±1, ±5	R294	0.294	±1	R422	0.422	±1	R604	0.604	±1	R887	0.887	±1
R137	0.137	±1	R205	0.205	±1	R300	0.3	±1, ±5	R430	0.43	±1, ±5	R619	0.619	±1	R909	0.909	±1
R140	0.14	±1	R210	0.21	±1	R301	0.301	±1	R432	0.432	±1	R620	0.62	±1, ±5	R910	0.91	±1, ±5
R143	0.143	±1	R215	0.215	±1	R309	0.309	±1	R442	0.442	±1	R634	0.634	±1	R931	0.931	±1
R147	0.147	±1	R220	0.22	±1, ±5	R316	0.316	±1	R453	0.453	±1	R649	0.649	±1	R953	0.953	±1
R150	0.15	±1, ±5	R221	0.221	±1	R324	0.324	±1	R464	0.464	±1	R665	0.665	±1	R976	0.976	±1

The specifications and designs contained herein may be subject to change without notice. Please contact our sales representatives or product engineers before order.

Operation Notes
Example of land Pattern Design
Recommended Soldering Conditions
General Structure
General
Precision
Jumper
Low ohms (RUT Series)
Ultra Low ohms (RU Series)
Ultra Low Ohms (RUK Series)
Ultra Low Ohms (RJ Series)
Arrays (CONVEX Type)
Arrays (CONCAVE Type)
Arrays (FLAT Type)
Anti-Sulfur Resistors
Attenuator
Characteristics Performance
Packaging
Standard Resistance Value



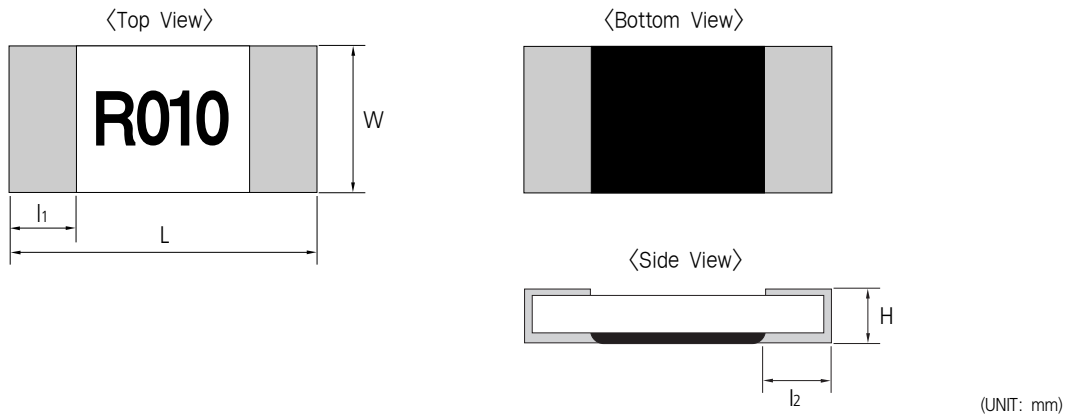
Feature

- Thick Film Type Ultra Low Ohm Resistor.
- High Precision Reliability.
- High Power with Low TCR.
- 100% Lead Free Products (PbO not used).
- RoHS Compliant.

Application

- Current Sensing.
- PCM of Battery Pack.
- Power supplying part, DC power charger, adapter.
- Mobile Phone, Mobile PC, Note PC, HDD, DSC, LCD.

Structure and Dimensions



Type	Inch	L	W	H	l ₁	l ₂	Average Weight
RU1005	0402	1.00±0.05	0.50±0.05	0.35±0.05	0.25±0.15	0.25±0.15	0.6mg
RU1608	0603	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.20	R≤0.05: 0.50±0.20 R>0.05: 0.35±0.20	2.2mg
RU2012	0805	2.00±0.15	1.25±0.15	0.55±0.10	0.40±0.20	R≤0.05: 0.65±0.20 R>0.05: 0.40±0.20	4.7mg
RU3216	1206	3.20±0.15	1.60±0.15	0.60±0.10	0.45±0.20	R≤0.05: 0.90±0.20 R>0.05: 0.60±0.20	9.4mg
RU3225	1210	3.20±0.20	2.55±0.20	0.55±0.10	0.45±0.20	R≤0.05: 1.2±0.20 R>0.05: 0.75±0.20	9.5mg
RU5025	2010	5.00±0.20	2.50±0.20	0.60±0.10	0.80±0.20	R≤0.05: 1.5±0.20 R>0.05: 0.90±0.20	27mg
RU6432	2512	6.30±0.20	3.20±0.20	0.60±0.10	1.00±0.20	R≤0.05: 1.90±0.20 R>0.05: 1.10±0.25	42mg

Parts Numbering System

- The part number system shall be in the following format

RU	2012	F	R051	CS
Code Designation	Dimension & Size Code	Tolerance	Resistance Value	Packaging Code
	1005: 1.0×0.5(mm) - 0402(inch)			
	1608: 1.6×0.8(mm) - 0603(inch)			
	2012: 2.0×1.2(mm) - 0805(inch)	F: ±1%		CS: Tape & Reel 7"
	3216: 3.2×1.6(mm) - 1206(inch)	G: ±2%	4-digit coding system	ES: Tape & Reel 10"
	3225: 3.2×2.5(mm) - 1210(inch)	J: ±5%		AS: Tape & Reel 13"
	5025: 5.0×2.5(mm) - 2010(inch)			
	6432: 6.4×3.2(mm) - 2512(inch)			

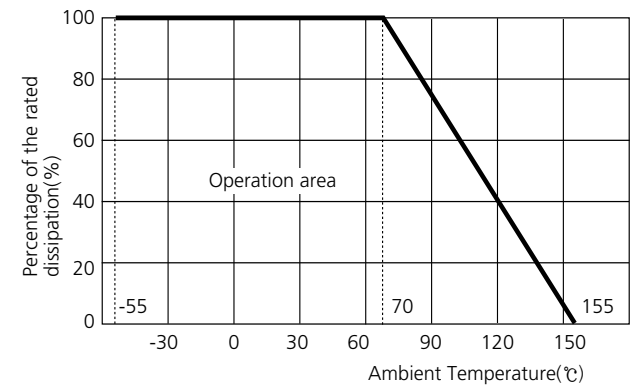
Specification

Type	Power Rating (W)	Rated Current (A)	Resistance Range (Ω)	T.C.R (ppm/℃)	Rated Ambient Temperature	Rated Working Temperature
RU1005	1/8 (0.125)	$\sqrt{P/R}$	25m~100m	R<47m: ± 500 R≥47m: ± 150	70℃	-55℃ ~+155℃
RU1608	1/4 (0.25)		10m~100m	R≤25m: ± 600 R<33m: ± 400 R≥33m: ± 150		
RU2012	1/3 (0.33)					
RU3216	1/2 (0.5)					
RU3225	2/3 (0.66)					
RU5025	3/4 (0.75)					
RU6432	1 (1)					

• Rated Current (A) = $\sqrt{\text{Rated Power(W)} / \text{Nominal Resistance Value(Ω)}}$
Please contact our sales representatives or product engineers for lower T.C.R or higher rated power products.

Power Derating Curve

The rated power is the maximum continuous loading power at 70℃ ambient temperature. For ambient temperature above 70℃, the loading power follows the below power derating curve.



Marking

4-digit Coding System

- R means decimal point.
- Other digits represent the significant value.
- Example : R010
R010 = .010 = 0.010Ω
= 0.01Ω or 10 mΩ



Resistance Value Table

Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)
R010	0.01	±1, ±5	R020	0.02	±1, ±5	R039	0.039	±1, ±5	R062	0.062	±1, ±5
R011	0.011	±1, ±5	R022	0.022	±1, ±5	R040	0.04	±1, ±5	R068	0.068	±1, ±5
R012	0.012	±1, ±5	R024	0.024	±1, ±5	R043	0.043	±1, ±5	R075	0.075	±1, ±5
R013	0.013	±1, ±5	R027	0.027	±1, ±5	R047	0.047	±1, ±5	R082	0.082	±1, ±5
R015	0.015	±1, ±5	R030	0.03	±1, ±5	R050	0.05	±1, ±5	R091	0.091	±1, ±5
R016	0.016	±1, ±5	R033	0.033	±1, ±5	R051	0.051	±1, ±5	R100	0.1	±1, ±5
R018	0.018	±1, ±5	R036	0.036	±1, ±5	R056	0.056	±1, ±5			

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Operation Notes

Example of land Pattern Design

Recommended Soldering Conditions

General Structure

General

Precision

Jumper

Low ohms (RUT Series)

Ultra Low ohms (RU Series)

Ultra Low Ohms (RUK Series)

Ultra Low Ohms (RJ Series)

Arrays (CONVEX Type)

Arrays (CONCAVE Type)

Arrays (FLAT Type)

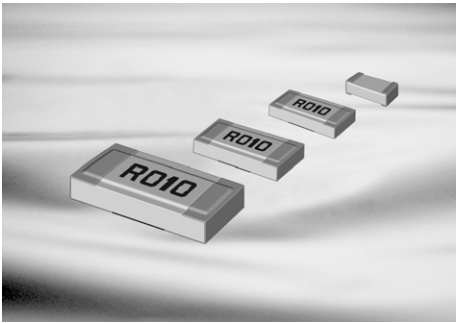
Anti-Sulfur Resistors

Attenuator

Characteristics Performance

Packaging

Standard Resistance Value



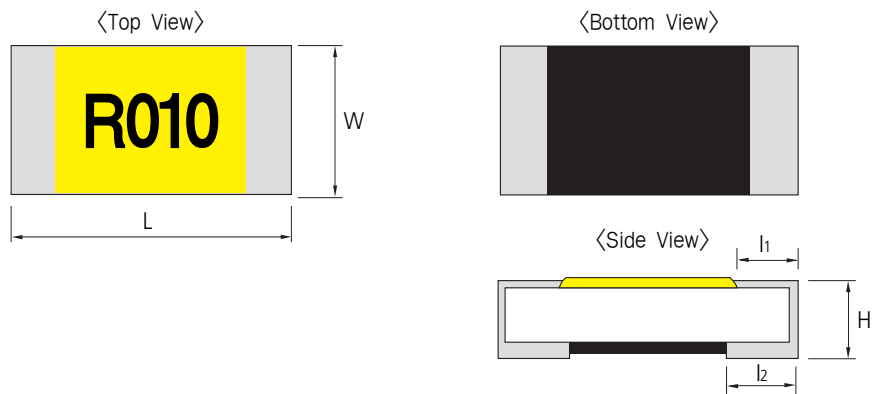
Feature

- Thick Film Type Ultra Low Ohm Resistor.
- High Precision Reliability.
- High Power with Very Low TCR.
- 100% Lead Free Products (PbO not used).
- RoHS Compliant.

Application

- Current Sensing.
- PCM of Battery Pack.
- Power supplying part, DC power charger, adapter.
- Mobile Phone, Mobile PC, Note PC, HDD, DSC, LCD.

Structure and Dimensions



(UNIT: mm)							
Type	Inch	L	W	H	l ₁	l ₂	Average Weight
RUK1608	0603	1.60±0.10	0.80±0.10	0.45±0.10	0.35±0.20	0.50±0.20	2.2mg
RUK2012	0805	2.00±0.15	1.25±0.15	0.55±0.10	0.40±0.20	0.55±0.20	4.7mg
RUK3216	1206	3.20±0.15	1.60±0.15	0.65±0.10	0.45±0.20	0.90±0.20	9.4mg
RUK3225	1210	3.20±0.20	2.55±0.20	0.60±0.10	0.45±0.20	0.90±0.20	9.5mg
RUK5025	2010	5.00±0.20	2.50±0.20	0.65±0.10	0.80±0.20	1.10±0.20	27mg
RUK6432	2512	6.30±0.20	3.20±0.20	0.65±0.10	1.0±0.20	1.90±0.20	42mg

Parts Numbering System

• The part number system shall be in the following format

RUK	1608	F	R010	CS
Code Designation	Dimension & Size Code	Tolerance	Resistance Value	Packaging Code

RUK : Current Sensing Resistor Low TCR	1608: 1.6 × 0.8(mm) - 0603(inch)	F: ±1% G: ±2% J: ±5%	4-digits coding system	CS: Tape & Reel 7" ES: Tape & Reel 10" AS: Tape & Reel 13"
	2012: 2.0 × 1.2(mm) - 0805(inch)			
	3216: 3.2 × 1.6(mm) - 1206(inch)			
	3225: 3.2 × 2.5(mm) - 1210(inch)			
	5025: 5.0 × 2.5(mm) - 2010(inch)			
	6432: 6.4 × 3.2(mm) - 2512(inch)			

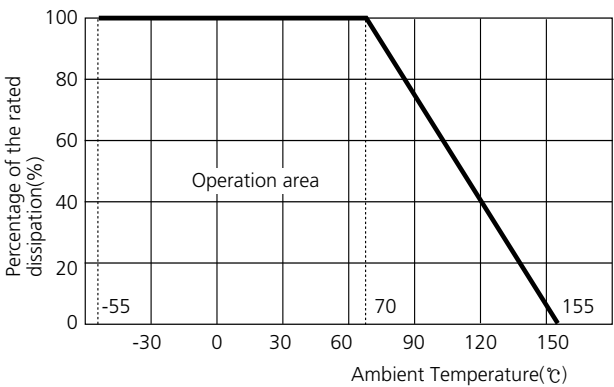
Specification

Type	Power Rating (W)	Rated Current (A)	Resistance Range (Ω)	T.C.R (ppm/℃)	Rated Ambient Temperature	Rated Working Temperature
RUK1608	1/2 (0.5)	$\sqrt{P/R}$	10m~30m	±100	70℃	-55℃~+155℃
RUK2012	1/2 (0.50)					
RUK3216	1 (1.0)					
RUK3225	1 (1.0)					
RUK5025	1 (1.0)					
RUK6432	1 (1.0)					

• Rated Current (A) = $\sqrt{\text{Rated Power(W)} / \text{Nominal Resistance Value(Ω)}}$
Please contact our sales representatives or product engineers for lower T.C.R or higher rated power products.

Power Derating Curve

The rated power is the maximum continuous loading power at 70℃ ambient temperature. For ambient temperature above 70℃, the loading power follows the below power derating curve.



Marking

4-digits coding system

- R means decimal point.
- Other digits represent significant value.
- Example : R010
R010 = .010 = 0.010Ω
= 0.01Ω or 10 mΩ



Resistance Value Table

Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)
R010	0.01	±1, ±5	R020	0.02	±1, ±5	R039	0.039	±1, ±5	R060	0.06	±1, ±5
R011	0.011	±1, ±5	R022	0.022	±1, ±5	R040	0.04	±1, ±5	R062	0.062	±1, ±5
R012	0.012	±1, ±5	R024	0.024	±1, ±5	R043	0.043	±1, ±5	R068	0.068	±1, ±5
R013	0.013	±1, ±5	R027	0.027	±1, ±5	R047	0.047	±1, ±5	R075	0.075	±1, ±5
R015	0.015	±1, ±5	R030	0.03	±1, ±5	R050	0.05	±1, ±5	R082	0.082	±1, ±5
R016	0.016	±1, ±5	R033	0.033	±1, ±5	R051	0.051	±1, ±5	R091	0.091	±1, ±5
R018	0.018	±1, ±5	R036	0.036	±1, ±5	R056	0.056	±1, ±5	R100	0.1	±1, ±5

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Operation Notes

Example of land Pattern Design

Recommended Soldering Conditions

General Structure

General

Precision

Jumper

Low ohms (RUT Series)

Ultra Low ohms (RU Series)

Ultra Low Ohms (RUK Series)

Ultra Low Ohms (RJ Series)

Arrays (CONVEX Type)

Arrays (CONCAVE Type)

Arrays (FLAT Type)

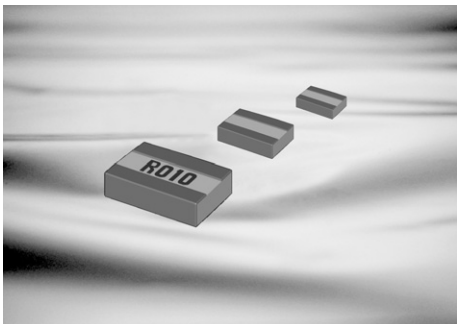
Anti-Sulfur Resistors

Attenuator

Characteristics Performance

Packaging

Standard Resistance Value



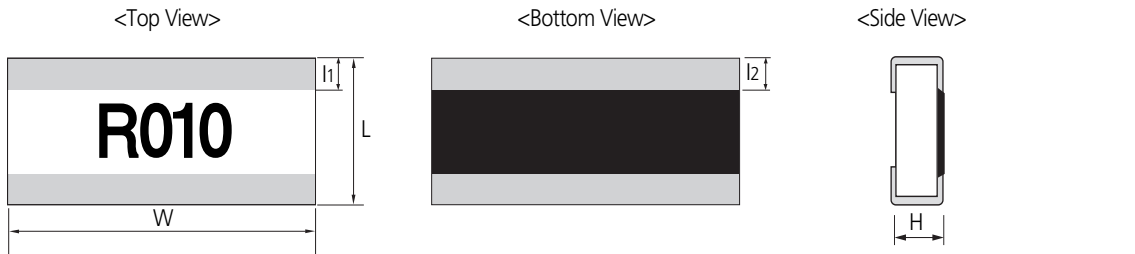
Feature

- Thick Film Wide Terminal Type.
- High Precision Reliability.
- High Power with Low TCR.
- 100% Lead Free Products (PbO not used).
- RoHS Compliant.

Application

- Current Sensing.
- PCM of Battery Pack.
- DC Power Charger, Adapter.
- Mobile Phone, Mobile PC, HDD, DSC, LCD.

Structure and Dimensions



Type	Inch	L	W	H	l ₁	l ₂	Average Weight
RJ0816	0306	0.80±0.10	1.60±0.10	0.45±0.15	0.25±0.15	0.30±0.15	2.3mg
RJ1220	0508	1.25±0.10	2.00±0.10	0.55±0.15	0.30±0.15	0.35±0.15	5mg
RJ1632	0612	1.60±0.15	3.20±0.15	0.55±0.15	0.35±0.20	0.40±0.20	10mg
RJ2037	0815	2.00±0.15	3.75±0.15	0.55±0.15	0.45±0.20	0.55±0.20	15mg
RJ3264	1225	3.20±0.20	6.40±0.20	0.55±0.15	0.60±0.20	0.60±0.20	40mg

Parts Numbering System

- The part number system shall be in the following format

R U K	1608	F	R010	CS
Code Designation	Dimension & Size Code	Tolerance	Resistance Value	Packaging Code
	0816 : 0.8 × 1.6(mm) - 0306(inch)			
RJ : Thick Film	1220 : 1.2 × 2.0(mm) - 0508(inch)	F: ±1%		CS: Tape & Reel 7"
Wide Terminal	1632 : 1.6 × 3.2(mm) - 0612(inch)	G: ±2%	4-digits coding system	ES : Tape & Reel 10"
CSR	2037 : 2.0 × 3.7(mm) - 0815(inch)	J: ±5%		AS: Tape & Reel 13"
	3264 : 3.2 × 6.4(mm) - 1225(inch)			

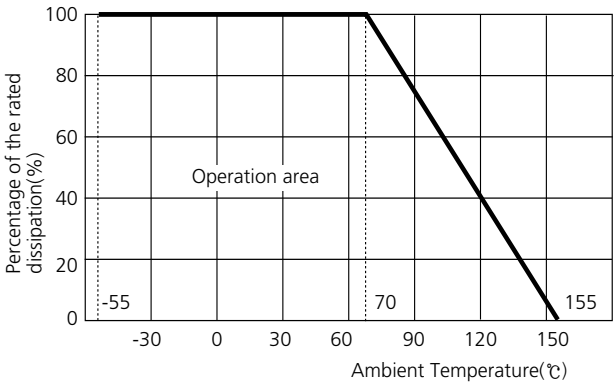
Specification

Type	Power Rating (W)	Rated Current (A)	Resistance Range (Ω)	T.C.R (ppm/°C)	Rated Ambient Temperature	Rated Working Temperature
RJ0618(0306)	1/2 (0.5)	$\sqrt{P/R}$	0.005~0.1 (5m~100m)	± 100	70℃	-55℃~+155℃
RJ1220(0508)	1					
RJ1632(0612)	1					
RJ2037(0815)	1					
RJ3264(1225)	2					

- Rated Current (A) = $\sqrt{\text{Rated Power(W)} / \text{Nominal Resistance Value(Ω)}}$
Please contact our sales representatives or production engineer for lower T.C.R or higher rated power products.

Power Derating Curve

The rated power is the maximum continuous loading power at 70℃ ambient temperature. For ambient temperature above 70℃, the loading power follows the below power derating curve.



Marking

4-digits coding system

- R means decimal point.
- Other digits represent significant value.
- Example : R010
R010 = .010 = 0.010Ω
= 0.01Ω or 10 mΩ



Resistance Value Table

Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)	Code	Value (Ω)	Tol (%)
R005	0.005	±1, ±5	R013	0.013	±1, ±5	R030	0.03	±1, ±5	R051	0.051	±1, ±5
R006	0.006	±1, ±5	R015	0.015	±1, ±5	R033	0.033	±1, ±5	R056	0.056	±1, ±5
R007	0.007	±1, ±5	R016	0.016	±1, ±5	R036	0.036	±1, ±5	R062	0.062	±1, ±5
R008	0.008	±1, ±5	R018	0.018	±1, ±5	R039	0.039	±1, ±5	R068	0.068	±1, ±5
R009	0.009	±1, ±5	R020	0.02	±1, ±5	R040	0.04	±1, ±5	R075	0.075	±1, ±5
R010	0.01	±1, ±5	R022	0.022	±1, ±5	R043	0.043	±1, ±5	R082	0.082	±1, ±5
R011	0.011	±1, ±5	R024	0.024	±1, ±5	R047	0.047	±1, ±5	R091	0.091	±1, ±5
R012	0.012	±1, ±5	R027	0.027	±1, ±5	R050	0.05	±1, ±5	R100	0.1	±1, ±5

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Operation Notes

Example of land Pattern Design

Recommended Soldering Conditions

General Structure

General

Precision

Jumper

Low ohms (RUT Series)

Ultra Low ohms (RU Series)

Ultra Low Ohms (RUK Series)

Ultra Low Ohms (RJ Series)

Arrays (CONVEX Type)

Arrays (CONCAVE Type)

Arrays (FLAT Type)

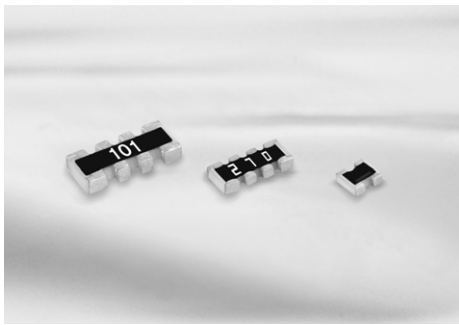
Anti-Sulfur Resistors

Attenuator

Characteristics Performance

Packaging

Standard Resistance Value



Feature

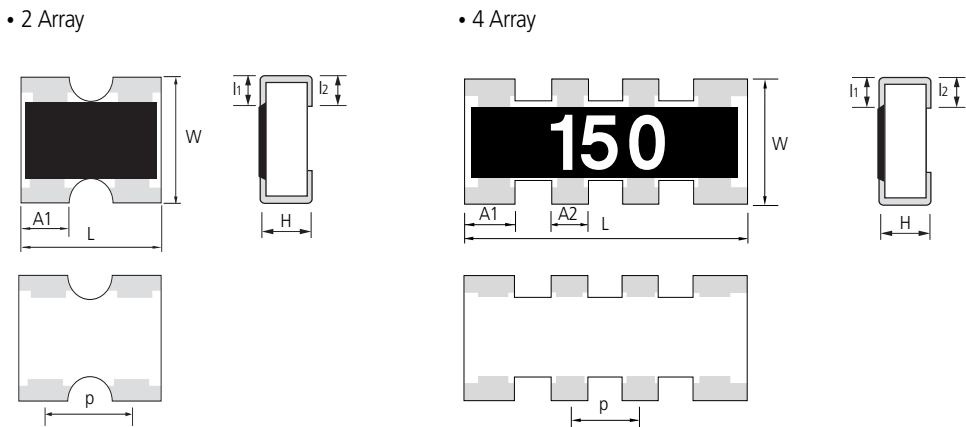
- Reducing SMD surface area (40% reduced).
- Reducing SMD costs (75% reduced).
- Both flow and reflow soldering are applicable.

The product of lead-free terminal is RoHS compliant.
PbO(lead oxide) is included in the glass of our product which is prescribed on RoHS appendix as an exception.

Application

- For semiconductor devices.
- For computers, digital circuits.

Structure and Dimensions



Type	L	W	H	A ₁	A ₂	I ₁	I ₂	P	Average Weight
RP102P	1.00±0.10	1.00±0.10	0.35±0.10	0.33±0.10	-	0.20±0.10	0.25±0.10	0.65±0.10	1.1mg
RP104P	2.00±0.10	1.00±0.10	0.35±0.10	0.30±0.15	0.40±0.15	0.15±0.10	0.25±0.15	0.50±0.15	2.2mg
RP164P	3.20±0.10	1.60±0.10	0.50±0.10	0.40±0.15	0.60±0.15	0.30±0.15	0.30±0.15	0.80±0.15	8.9mg

(UNIT: mm)

Parts Numbering System

- The part number system shall be in the following format

RP	10	4P	J	100	CS
Code Designation	Dimension	Resistors	Tolerance	Resistance Value	Packaging Code
RP: Convex type array	10 : 1005 16 : 1608	2P: 2 Pieces 4P: 4 Pieces	J: ±5%	3 digit coding system (IEC coding system) E-24 series	CS : Tape Packaging 7" ES : Tape Packaging 10" AS : Tape Packaging 13"

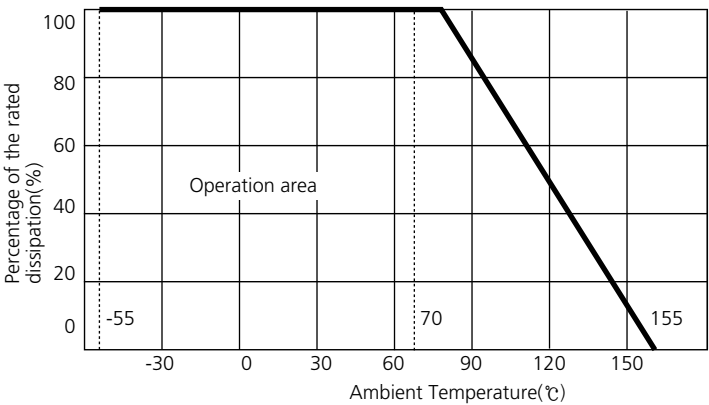
Specification

Type	Power Rating (W)	Working Voltage (MAX)	Overload Voltage (MAX)	TCR (ppm/°C)	Resistance Range (Ω)	Rated Ambient Temperature	Rated Working Temperature
102P	1/16	25(V)	50(V)	1 Ω ~ 99 Ω : ±300 10 Ω ~ 1 MΩ : ±200	1 Ω ~ 1M Ω	70 °C	-55 °C ~ +155 °C
104P		25(V)	50(V)				
164P		50(V)	100(V)				

• Rated voltage (V) = $\sqrt{\text{Rated power(W)} \times \text{Nominal resistance value (Ω)}}$
Rated voltage should be lower than (MAX) working voltage.

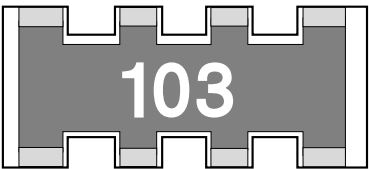
Power Derating Curve

The rated power is the maximum continuous loading power at 70°C ambient temperature.
For ambient temperature above 70°C, the loading power follows the below power derating curve.

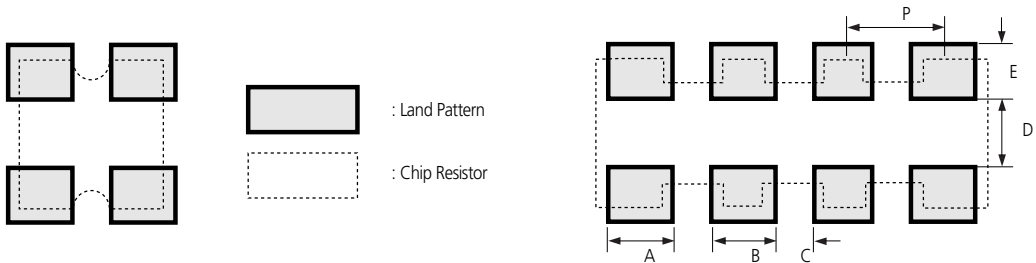


Marking

- 3 digits indication(E-24 series)
 - Left 2 digits represent significant figures.
 - Last 1 digit represents exponential number of 10.
 - Example: 103
 - Left 2 digits: 10
 - Last 1 digit: 3
 - $103 = 10 \times 10^3 = 10000 \Omega = 10k\Omega$
- RP102P : No marking.



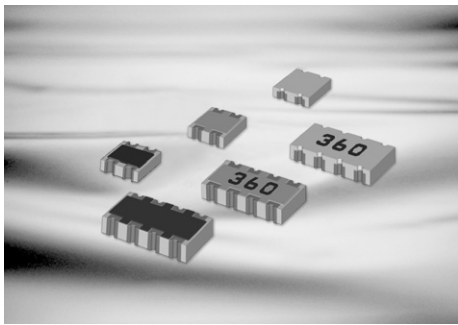
Land Pattern



Type	A	B	C	D	E	P ₁	P ₂
10AT	0.4	0.4	0.25	0.5	0.5	0.65	-
102P	0.4	0.4	0.25	0.5	0.5	0.65	
104P	0.7	0.3	0.2	0.5	0.5	0.55	0.5
164P	0.7	0.5	0.3	0.9	0.8	0.9	0.8

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Please contact our sales representatives or product engineers before order.

- Operation Notes
- Example of land Pattern Design
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- General Structure
- General
- Precision
- Jumper
- Low ohms (RUT Series)
- Ultra Low ohms (RU Series)
- Ultra Low Ohms (RUK Series)
- Ultra Low Ohms (RJ Series)
- Arrays (CONVEX Type)
- Arrays (CONCAVE Type)
- Arrays (FLAT Type)
- Anti-Sulfur Resistors
- Attenuator
- Characteristics Performance
- Packaging
- Standard Resistance Value



Feature

- Strong Body.
- Both flow and reflow soldering are applicable.
- Concave Type Terminal.

The product of lead-free terminal is RoHS compliant.
PhO(lead oxide) is included in the glass of our product which is prescribed on RoHS appendix as an exception.

Application

- For semiconductor devices.
- For computers, digital circuits.

Structure and Dimensions

(1) Reverse Concave Type

Top View

Side View

Bottom View

(UNIT: mm)

Type	Inch	L	W	H	A1	A2	l1	l2	P	Average Weight
RN102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.30±0.10	-	0.15±0.10	0.25±0.15	0.50±0.10	1.2mg
RN104P	0402x4R	2.00±0.10	1.00±0.10	0.40±0.10	0.30±0.10	0.30±0.10	0.15±0.10	0.25±0.15	0.50±0.10	2.8mg

(2) Inverted Concave Type

Top View

Side View

Bottom View

(UNIT: mm)

Type	Inch	L	W	H	A1	A2	l1	l2	P	Average Weight
RM102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.30±0.10	-	0.15±0.10	0.25±0.15	0.50±0.10	1.2mg
RM104P	0402x4R	2.00±0.10	1.00±0.10	0.40±0.10	0.30±0.10	0.30±0.10	0.15±0.10	0.25±0.15	0.50±0.10	2.8mg

(3) Short-free & Inverted Concave Type

Top View

Side View

Bottom View

(UNIT: mm)

Type	Inch	L	W	H	A1	A2	l1	l2	P	Average Weight
RK102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.30±0.10	-	-	0.25±0.15	0.50±0.10	1.2mg
RK104P	0402x4R	2.00±0.10	1.00±0.10	0.40±0.10	0.30±0.10	0.30±0.10	-	0.25±0.15	0.50±0.10	2.8mg

Parts Numbering System

- The part number system shall be in the following format

RN	10	4P	J	1 0 0	CS
Code Designation	Dimension	Resistors	Tolerance	Resistance Value	Packaging Code
RN : Concave Type Array RM : Inverted Type Array RK : Short Free & Inverted Type	10: 1005	2P: 2 Pieces 4P: 4 Pieces	F: ±1% J: ±5%	3 digit coding system (IEC coding system) E-24 series	CS : Tape Packaging 7" ES : Tape Packaging 10" AS : Tape Packaging 13"

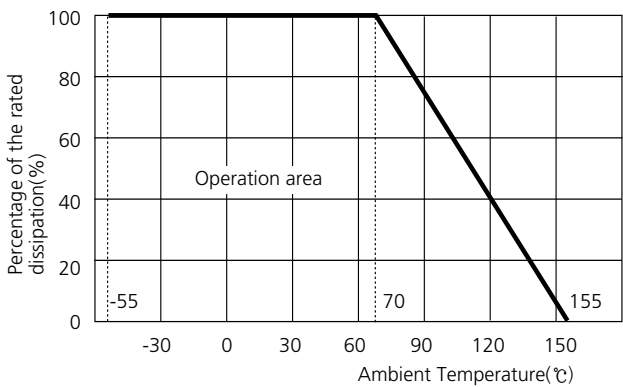
Specification

Type	Power Rating (W)	Working Voltage (MAX)	Overload Voltage (MAX)	TCR (ppm/℃)	Resistance Range (Ω)	Rated Ambient Temperature	Rated Working Temperature
102P	1/16	25(V)	50(V)	1~9.9 Ω: ±300	1 Ω~1MΩ	70℃	-55℃~+155℃
104P		25(V)	50(V)	10 Ω~1MΩ: ±200			

Rated voltage (V) = $\sqrt{\text{Rated power(W)} \times \text{Nominal resistance value (Ω)}}$
Rated voltage should be lower than (MAX) working voltage.

Power Derating Curve

The rated power is the maximum continuous loading power at 70℃ ambient temperature.
For ambient temperature above 70℃, the loading power follows the below power derating curve.



Land Pattern

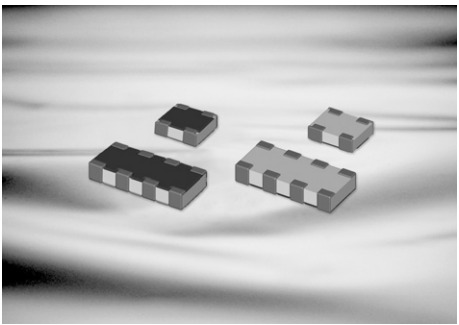
: Land Pattern

: Chip Resistor

Type	A	B	C	D	E	P
102P	0.3	0.3	0.2	0.5	0.4	0.5
104P	0.3	0.3	0.2	0.5	0.4	0.5

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Please contact our sales representatives or product engineers before order.

Operation Notes
Example of land Pattern Design
Recommended Soldering Conditions
General Structure
General
Precision
Jumper
Low ohms (RUT Series)
Ultra Low ohms (RU Series)
Ultra Low Ohms (RUK Series)
Ultra Low Ohms (RJ Series)
Arrays (CONVEX Type)
Arrays (CONCAVE Type)
Arrays (FLAT Type)
Anti-Sulfur Resistors
Attenuator
Characteristics Performance
Packaging
Standard Resistance Value



- Feature
- Very Small Array.
 - Stable and Accurate Resistance.
 - Flat Type Terminal.
- The product of lead-free terminal is RoHS compliant.
PhO(lead oxide) is included in the glass of our product which is prescribed on RoHS appendix as an exception.
- Application
- For semiconductor devices.
 - For computers, digital circuits.

Structure and Dimensions

(1) Flat Type Array

Type	Inch	L	W	H	A1	A2	D	l1	l2	P	Average Weight
RF062P	0201x2R	0.80±0.05	0.60±0.05	0.23±0.10	0.30±0.10	-	Min 0.1	0.10±0.10	0.20±0.10	0.50±0.05	0.3mg
RF064P	0201x4R	1.40±0.05	0.60±0.05	0.23±0.10	0.25±0.10	0.25±0.10	Min 0.1	0.10±0.10	0.20±0.10	0.35±0.05	0.5mg

(2) Inverted Type Array

Type	Inch	L	W	H	A1	A2	D	l1	l2	P	Average Weight
RM062P	0201x2R	0.80±0.05	0.60±0.05	0.23±0.10	0.30±0.10	-	Min 0.1	0.10±0.10	0.20±0.10	0.50±0.05	0.3mg
RM064P	0201x4R	1.40±0.05	0.60±0.05	0.23±0.10	0.30±0.10	0.30±0.10	Min 0.1	0.10±0.10	0.15±0.10	0.40±0.05	0.5mg

Parts Numbering System

- The part number system shall be in the following format

RF	06	4P	J	150	CS
Code Designation	Dimension	Resistors	Tolerance	Resistance Value	Packaging Code
RF : Flat Type Array RM : Inverted Type Array	06: 0603	2P: 2 Pieces 4P: 4 Pieces	J: ±5%	3 digit coding system (IEC coding system) E-24 series	CS : Tape Packaging 7" ES : Tape Packaging 10" AS : Tape Packaging 13"

Specification

Type	Power Rating (W)	Working Voltage (MAX)	Overload Voltage (MAX)	TCR (ppm/°C)	Resistance Range (Ω)	Rated Ambient Temperature	Rated Working Temperature
062P 064P	1/32	12.5(V)	25(V)	±250	10 Ω~1M Ω	70°C	-55°C~+125°C

• Rated voltage (V) = $\sqrt{\text{Rated power(W)} \times \text{Nominal resistance value } (\Omega)}$
Rated voltage should be lower than (MAX) working voltage.

Power Derating Curve

The rated power is the maximum continuous loading power at 70°C ambient temperature.
For ambient temperature above 70°C, the loading power follows the below power derating curve.

Ambient Temperature(°C)	Percentage of the rated dissipation(%)
-55	100
70	100
125	0

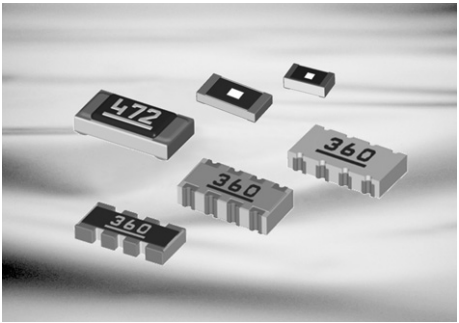
Land Pattern

: Land Pattern
: Chip Resistor

TYPE (Inch)	Reflow Soldering				
Dimension	A	B	2A + B	C	D
062P	0.3	0.3	0.9	0.2	0.3
064P	0.3	0.3	0.9	0.2	0.2

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- Arrays (CONCAVE Type)
- Arrays (FLAT Type)
- Anti-Sulfur Resistors
- Attenuator
- Characteristics Performance
- Packaging
- Standard Resistance Value



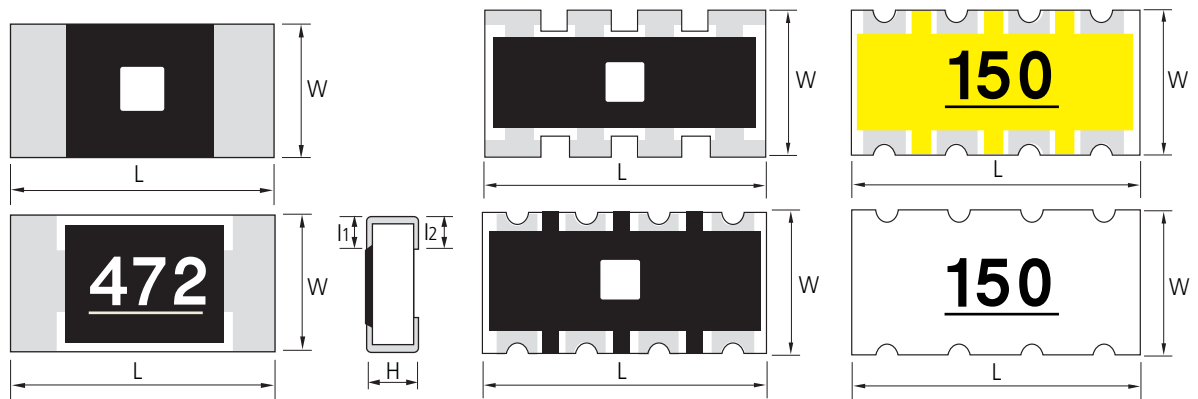
Feature

- Stable in the Sulfur Atmosphere.
- ASTM Satisfied.
- Passed 720hrs with the dried Sulfur at 105℃.
- High Precision Reliability.
- RoHS Compliant.

Application

- Electronic Devices with long-term reliability.
- Server System (Memory Module / HDD).
- Network Equipment.
- Automotive ECU parts.

Structure and Dimensions



(UNIT: mm)

Type	Inch	L	W	H	A ₁	A ₁	h ₁	l ₂	P	Average Weight
RCS0603	0201	0.60±0.03	0.30±0.03	0.23±0.03			0.10±0.05	0.15±0.05		0.15mg
RCS1005	0402	1.00±0.05	0.50±0.05	0.35±0.05			0.20±0.10	0.25±0.10		0.6mg
RCS1608	0603	1.60±0.10	0.80±0.10	0.45±0.10			0.30±0.20	0.35±0.10		2.1mg
RCS2012	0805	2.00±0.15	1.25±0.15	0.50±0.10			0.40±0.20	0.35±0.20		4.9mg
RCS3216	1206	3.20±0.15	1.60±0.15	0.55±0.10			0.45±0.20	0.40±0.20		9.5mg
RCS3225	1210	3.20±0.20	2.55±0.20	0.55±0.10			0.45±0.20	0.40±0.20		16mg
RCS5025	2010	5.00±0.20	2.50±0.20	0.55±0.10			0.60±0.20	0.60±0.20		26mg
RCS6432	2512	6.30±0.20	3.20±0.20	0.55±0.10			0.60±0.20	0.60±0.20		41mg
RPS102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.33±0.10		0.20±0.10	0.25±0.10		1.1mg
RPS104P	0402x4R	2.00±0.10	1.00±0.10	0.35±0.10	0.40±0.15	0.30±0.15	0.15±0.10	0.25±0.10	0.65±0.10	2.2mg
RPS164P	0603x4R	3.20±0.10	1.60±0.10	0.50±0.10	0.60±0.15	0.40±0.15	0.30±0.15	0.30±0.15	0.50±0.15	8.9mg
RNS102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.30±0.10	-	0.15±0.10	0.25±0.15	0.80±0.15	1.2mg
RNS104P	0402x4R	2.00±0.10	1.00±0.10	0.40±0.10	0.30±0.10	0.30±0.10	0.15±0.10	0.25±0.15	0.50±0.10	2.8mg
RMS102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.30±0.10	-	0.15±0.10	0.25±0.15	0.50±0.10	1.2mg
PMS104P	0402x4R	2.00±0.10	1.00±0.10	0.45±0.10	0.30±0.10	0.30±0.10	0.15±0.10	0.25±0.15	0.50±0.10	2.8mg
RKS102P	0402x2R	1.00±0.10	1.00±0.10	0.35±0.10	0.30±0.10	-	-	0.25±0.15	0.50±0.10	1.2mg
RKS104P	0402x4R	2.00±0.10	1.00±0.10	0.45±0.10	0.30±0.10	0.30±0.10	-	0.25±0.15	0.50±0.10	2.8mg
RFS062P	0201x2R	0.80±0.05	0.60±0.05	0.23±0.10	0.20±0.10	-	0.10±0.10	0.20±0.10	0.50±0.05	0.3mg
RFS064P	0201x4R	1.40±0.05	0.60±0.05	0.23±0.10	0.20±0.10	0.20±0.10	0.10±0.10	0.20±0.10	0.40±0.05	0.5mg
RMS062P	0201x2R	0.80±0.05	0.60±0.05	0.23±0.10	0.20±0.10	-	0.10±0.10	0.20±0.10	0.50±0.05	0.3mg
RMS064P	0201x4R	1.40±0.05	0.60±0.05	0.23±0.10	0.20±0.10	0.20±0.10	0.10±0.10	0.20±0.10	0.40±0.05	0.5mg

Parts Numbering System

- The part number system shall be in the following format

RCS	2012	J	100	CS
Code Designation	Dimension & Size Code	Tolerance	Resistance Value	Packaging Code
	0603: 0.6 × 0.3(mm) - 0201(inch) 1005: 1.0 × 0.5(mm) - 0402(inch) 1608: 1.6 × 0.8(mm) - 0603(inch) 2012: 2.0 × 1.2(mm) - 0805(inch) 3216: 3.2 × 1.6(mm) - 1206(inch) 3225: 3.2 × 2.5(mm) - 1210(inch) 5025: 5.0 × 2.5(mm) - 2010(inch) 6432: 6.4 × 3.2(mm) - 2512(inch) 062P: 0603 × 2R (0201x2R) 064P: 0603 × 4R (0201x4R) 102P: 0603 × 2R (0402x2R) 104P: 1005 × 4R (0402x4R) 164P: 1608 × 4R (0603x4R)	F : ±1% G : ±2% J : ±5% K : ±10%	3 or 4 digits coding system (IEC coding system) 3digits (E-24 series) 4digits (E-96 series)	GS: Bulk Packaging CS: Tape Packaging 7" ES: Tape Packaging 10" AS: Tape Packaging 13"

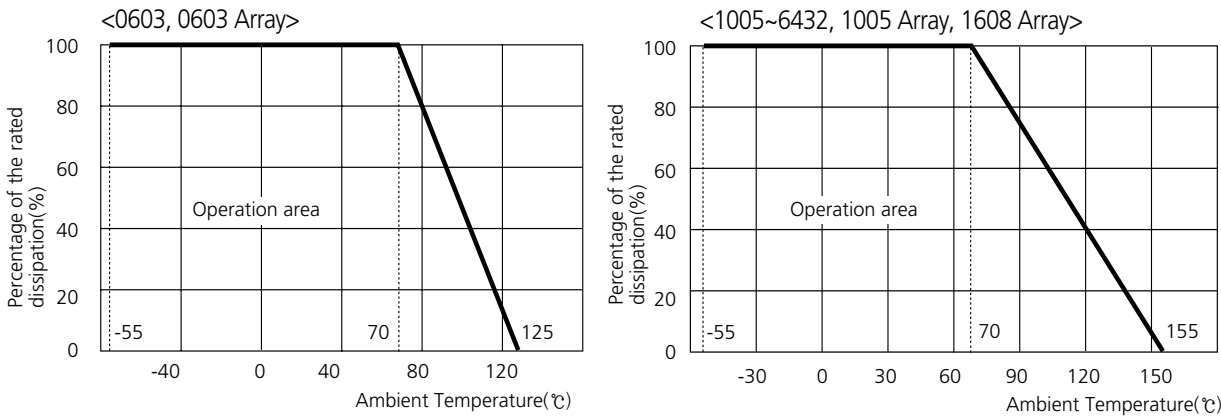
Specification

Type	Power Rating (W)	Working Voltage (MAX)	Overload Voltage (MAX)	TCR (ppm/℃)	Resistance Range (Ω)	Rated Ambient Temperature	Rated Working Temperature
RC 0603	1/20	25(V)	50(V)	1~99 Ω : +300,-200 10 Ω~1 MΩ: ±100 (0603 : ±250) 1.1 MΩ~10 MΩ: ±300	1 Ω~10 MΩ	70℃	-55℃~+125℃
RC 1005	1/16	50(V)	100(V)				-55℃~+155℃
RC 1608	1/10						
RC 2012	1/8						
RC 3216	1/4	200(V)	400(V)				
RC 3225	1/3						
RC 5025	2/3						
RC 6432	1						
062P	1/32	12.5(V)	25(V)	±250	10 Ω~1 MΩ	70℃	-55℃~+125℃
064P							
102P	1/16	25(V)	50(V)	1~99 Ω : ±300 10 Ω~1 MΩ: ±200	1 Ω~1 MΩ	70℃	-55℃~+155℃
104P		25(V)	50(V)				
164P		50(V)	100(V)				

• Rated voltage (V) = $\sqrt{\text{Rated power(W)} \times \text{Nominal resistance value (R)}}$
Rated voltage should not exceed the working voltage.

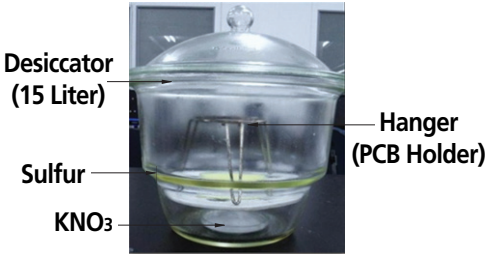
Power Derating Curve

The rated power is the maximum continuous loading power at 70℃ ambient temperature.
For ambient temperature above 70℃, the loading power follows the below power derating curve.
(The load current shall be derated according to derating curve in case of the 'Jumper')



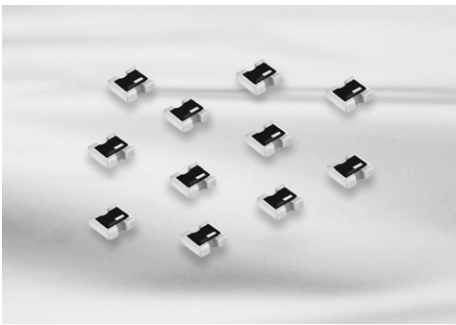
Sulfur Corrosion Test

Test name	Adding Material	Temperature	Duration Time	Decision Criteria
ASTM B-809-5	Sulfur 50 g KONs 200 g DI water 200ml	50℃	1000hr	ΔR<±1%
Dry Sulfur (IBM recommended)	Sulfur 50 g	105℃	720hr	ΔR<±1%



[Test Equipment]

- Operation Notes
- Example of land Pattern Design
- Recommended Soldering Conditions
- General Structure
- General
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- Jumper
- Low ohms (RUT Series)
- Ultra Low ohms (RU Series)
- Ultra Low Ohms (RUK Series)
- Ultra Low Ohms (RJ Series)
- Arrays (CONVEX Type)
- Arrays (CONCAVE Type)
- Arrays (FLAT Type)
- Anti-Sulfur Resistors
- Attenuator
- Characteristics Performance
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- Standard Resistance Value



Feature

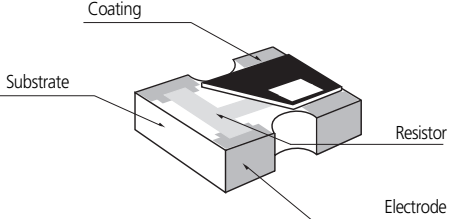
- The RP10AT is small-size chip Attenuator, suitable for high density surface mounting.
- Unbalanced π type attenuator circuit in one chip(1.0 mm x 1.0 mm).
- Mounting occupation area reduction : about 50 % reduction.
- Mounting cost reduction : Mounting times 3 times $\rightarrow$ 1 time.
- Attenuation : 0 dB to 10 dB.

Application

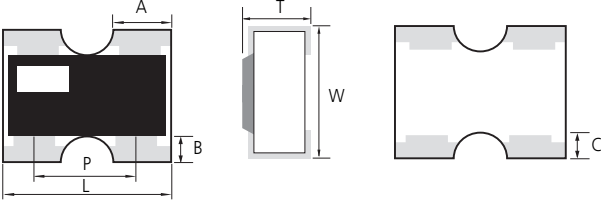
- Attenuation / level control / impedance matching of high frequency signals of communication equipment; cellular phones(GSM, CDMA, etc.), PHS, PDA, for example.

Structure and Dimensions

• Structure



• Dimensions



(UNIT: mm)

Type	Power(W)	L	W	T	A	B	C	P	Average Weight
RP10AT	0.04W / package	1.00 $\pm$ 0.10	1.00 $\pm$ 0.10	0.35 $\pm$ 0.10	0.33 $\pm$ 0.05	0.20 $\pm$ 0.10	0.25 $\pm$ 0.10	0.65 $\pm$ 0.10	1.1mg

Parts Numbering System

• The part number system shall be in the following format

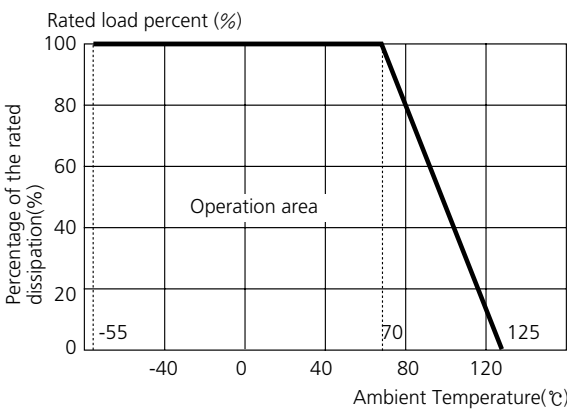
RP	10AT	L	A	03	CS
Code Designation	Dimensions & Circuit Configuration	Attenuation Value Tolerance	Characteristic Impedance	Attenuation Value	Packing Type
RP:Convex type	10:1.0x1.0(mm)-0404(inch) AT:Unbalanced π -type Attenuator	L : $\pm$ 0.3 dB H : $\pm$ 0.5 dB	A : 50 ohm	3 dB EX) 0 $\rightarrow$ 0dB	CS:Tape Packaging 7"

Specification

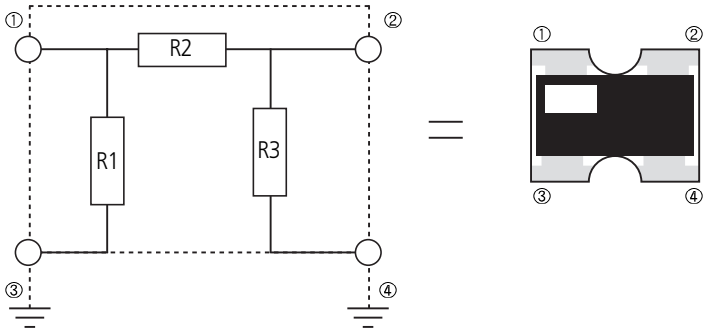
Item	Specifications
Attenuation Value	0 dB~15dB
Attenuation Value Tolerance	0 dB~5 dB : $\pm$ 0.3 dB 6 dB~15dB : $\pm$ 0.5 dB
Characteristic Impedance	50 Ω
Power Rating	0.04W / package
Frequency Range	DC to 3 GHz
VSWR (Voltage Standing Wave Ratio)	1.3 max
Number of terminals	4 terminals
Category Temperature Range (Operating Temperature Range)	-55 $^{\circ}$ C to +125 $^{\circ}$ C

Power Derating Curve

The rated power is the maximum continuous loading power at 70 $^{\circ}$ C ambient temperature.
For ambient temperature above 70 $^{\circ}$ C, the loading power follows the below power derating curve.

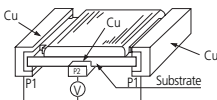


Equivalent Circuit Configuration

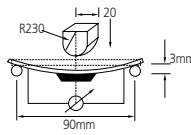


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Ultra Low ohms (RU Series)
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Arrays (CONVEX Type)
Arrays (CONCAVE Type)
Arrays (FLAT Type)
Anti-Sulfur Resistors
Attenuator
Characteristics Performance
Packaging
Standard Resistance Value

Electrical Characteristic

Item			Requirements Specification		Test Methods	
			Resistor	Jumper	Resistor	Jumper
Direct Current Resistance			Within the regulated resistance tolerance.	50m Ω Max.	JIS C 5201-1 4.5 Voltage apply Within 5 sec. Test temp: 20℃, 65RH Test board: <FIG. 1>	
Temperature Characteristic			■J-Grade 1 Ω ≤ R <10 Ω :+300/-200ppm/℃ 10 Ω ≤ R ≤ 1M Ω :±100ppm/℃(0603±250ppm) 1M Ω < R ≤ 10M Ω :±300ppm/℃ ■F-Grade 1 Ω ≤ R ≤ 10M Ω :±100ppm/℃(0603±250ppm)		JIS C 5201-1 4.8 Test Temperature(℃) 20℃ → -55℃ / 20℃ → 125℃ T.C.R/(ppm/℃)=(R-R ₂₀) / R ₂₀ × 1/(T-T ₂₀) × 10 ⁶ ※T=test Temperature, T ₂₀ =20℃ R=Resistance at T, R ₂₀ =Resistane at T ₂₀ Test board: <FIG. 1>	
Short-time Overload	Δ R	Less than ±(1%+0.1 Ω) of the initial value.	50m Ω Max.	JIS C 5201-1 4.13 Apply 2.5 times rated voltage for 5 sec. Wait 60 minutes at room temperature. Measure the resistance value. Test board: <FIG. 1>	Max Surge Current	
	Visual	No evidence of mechanical damage.				
Intermittent Overload	Δ R	Less than ±(3%+0.1 Ω) of the initial value.	50m Ω Max.	JIS C 5201-1 4.13 2.5 times of rated voltage . 1 second ON, 25 second OFF. 10,000 cycles. Test board: <FIG. 1>	Max Surge Current	
	Visual	No evidence of mechanical damage.				
Dielectric Withstanding Voltage	No evidence of mechanical damage.			JIS C 5201-1 4.7 Apply Voltage for 1 minute 0402.0603:50V 1005, 1608: 100V Other: 500V		
Insulation Resistance	Over 1,000M Ω					

Mechanical Characteristic

Item		Requirements Specification		Test Methods	
		Resistor	Jumper	Resistor	Jumper
Solderability		Coverage: ≥95% each termination. No crack of termination parts and ceramic exposure of surface by melting.		IEC60068-2-58 Rosin Flux: Rosin 25%, Methanol 75% Solder Temp.: 245±5/-0℃ Dipping time: 2±0.5 sec.(Both side dipping)	
Bending Test	ΔR	Less than±(1.0%+0.05Ω) of the initial value.	50mΩ Max.	JIS C 5201-1 4.33 After soldering resistor on the PCB, 3mm of bending shall be applied for 10 sec. Test board: <FIG. 2> 	
	Visual	No evidence of mechanical damage.			
Adhesive strength of termination		·No mechanical damage or sign of disconnection		JIS C 5201-1(4.16) – Test strength : 5N (500g · f), 0603 : 2N – Test time : Applying pressure for 10 seconds 	
Resistance to Soldering Heat	ΔR	Less than±(1%+0.05Ω) of the initial value.	50mΩ Max.	JIS C 5201-1 4.18 – Flow soldering :260±5℃, 10 sec .max.(both side dipping) – Reflow soldering :260±5℃, 10 sec. max. over 230℃, 30~40 sec.	
	Visual	No evidence of mechanical damage.			
Anti-Vibration Test	ΔR	Less than±(1%+0.05Ω) of the initial value.	50mΩ Max.	JIS C 5201-1 4.22 2 hours each in X, Y and Z axis(total 6 hours) 10 to 55Hz sweep in 1 minute at 1.5mm amplitude.	
	Visual	No evidence of mechanical damage.			

Environmental Characteristic

Item		Requirements Specification		Test Methods	
		Resistor	Jumper	Resistor	Jumper
Temperature Cycle	ΔR	Less than ±(1%+0.1 Ω) of the initial value.	50mΩ Max.	JIS C 5201-1 4.19 Perform 100 cycles as follows. Test Condition: -55 ℃/30min ↔ 125 ℃/30min sweep time: 5 min Test board: <FIG. 1>	
	Visual	No evidence of mechanical damage.			
Load Life	ΔR	Less than ±(3%+0.1 Ω) of the initial value.	50mΩ Max.	JIS C 5201-1 4.25 Test Voltage: rated voltage Test temp.: 70±2 ℃ Time: 1,000 ⁺⁴⁸ hours(90 min; ON, 30 min; OFF) Test board: <FIG. 1>	
	Visual	No evidence of mechanical damage.			
Low Temp. Exposure	ΔR	Less than ±(3%+0.1 Ω) of the initial value.	50mΩ Max.	JIS C 5201-1 4.23 Dwell in -55 ℃ chamber without loading for 1,000 ⁺⁴⁸ hour Stabilize for 60 minutes at room temperature. Measure value. Test board: <FIG. 1>	
	Visual	No evidence of mechanical damage.			
High Temp. Exposure	ΔR	Less than ±(3%+0.1 Ω) of the initial value.	50mΩ Max.	JIS C 5201-1 4.23 Dwell in 125 ℃±2 ℃ or 155 ℃±2 ℃chamber without loading for 1,000 ⁺⁴⁸ hours. Stabilize for 60 minutes at room temperature. Measure value. Test board: <FIG. 1>	
	Visual	No evidence of mechanical damage.			
Moisture Resistance	ΔR	Less than ±(3%+0.1 Ω) of the initial value.	50mΩ Max.	JIS C 5201-1 4.14 Test Voltage: rated voltage Test temp.: 40±2 ℃ Time: 1,000 ⁺⁴⁸ hours(90 min; ON, 30 min; OFF) Humidity: 90~95% RH Stabilize for 1 hrs & Measure. Test board: <FIG. 1>	
	Visual	No evidence of mechanical damage.			

※ These characteristics apply to 1Ω ~ 10MΩ. In case of other resistance range, please contact us.
※ The next is specification in our company for flow soldering and test boards.

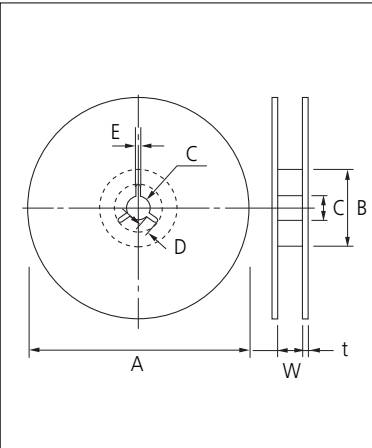
Flow soldering Conditions

Item	Specification	Dipping
Flux	ROSIN 25%, IPA 75%	Time: 5~10 sec.
Solder	Sn-3.0Ag-0.5Cu	Time: 10 sec max. Temp.: 260±5℃.

- Operation Notes
- Example of land Pattern Design
- Recommended Soldering Conditions
- General Structure
- General
- Precision
- Jumper
- Low ohms (RUT Series)
- Ultra Low ohms (RU Series)
- Ultra Low Ohms (RUK Series)
- Ultra Low Ohms (RJ Series)
- Arrays (CONVEX Type)
- Arrays (CONCAVE Type)
- Arrays (FLAT Type)
- Anti-Sulfur Resistors
- Attenuator
- Characteristics Performance
- Packaging
- Standard Resistance Value

Taping Type

• Reel dimensions



Unit: mm					
Symbol	Tape Width	A	B	C	D
7" Reel	8mm	$\varnothing 180 \pm 0.3$	$\varnothing 60 \pm 1.0$	$\varnothing 13 \pm 0.3$	4 ± 0.2
	12mm	$\varnothing 180 \pm 0.3$	$\varnothing 60 \pm 1.0$	$\varnothing 13 \pm 0.3$	4 ± 0.2
10" Reel	8mm	$\varnothing 258 \pm 0.3$	$\varnothing 80 \pm 1.0$	$\varnothing 13 \pm 0.3$	4 ± 0.2
	12mm	$\varnothing 258 \pm 0.3$	$\varnothing 80 \pm 1.0$	$\varnothing 13 \pm 0.3$	4 ± 0.2
13" Reel	8mm	$\varnothing 330 \pm 2.0$	$\varnothing 100 \pm 1.0$	$\varnothing 13 \pm 0.3$	4 ± 0.2
	12mm	$\varnothing 330 \pm 2.0$	$\varnothing 80 \pm 1.0$	$\varnothing 13 \pm 0.3$	4 ± 0.2
Symbol	Tape Width	E	W	t	
7" Reel	8mm	2.0 ± 0.5	9 ± 0.5	1.2 ± 0.2	
	12mm	2.0 ± 0.5	13 ± 0.5	1.2 ± 0.2	
10" Reel	8mm	2.0 ± 0.5	9 ± 0.5	1.8 ± 0.2	
	12mm	2.0 ± 0.5	13 ± 0.5	1.8 ± 0.2	
13" Reel	8mm	2.0 ± 0.5	9 ± 0.5	2.2 ± 0.2	
	12mm	2.0 ± 0.5	13 ± 0.5	2.2 ± 0.2	

• Tape dimensions

(UNIT: mm)

Type	Pitch	Width	Dimensions																																												
Press Pocket or Punched Paper	2mm	8mm	<table><tr><th></th><th>A</th><th>B</th><th>T</th></tr><tr><td>0402</td><td>0.24±0.03</td><td>0.45±0.03</td><td>0.5 Max</td></tr><tr><td>0603</td><td>0.38±0.05</td><td>0.68±0.05</td><td>0.5 Max</td></tr><tr><td>1005</td><td>0.70±0.10</td><td>1.20±0.10</td><td>0.6 Max</td></tr><tr><td>RF062P</td><td>0.70±0.10</td><td>0.90±0.10</td><td>0.35 Max</td></tr><tr><td>RF064P</td><td>0.70±0.10</td><td>1.60±0.10</td><td>0.35 Max</td></tr><tr><td>RP102</td><td>1.17±0.10</td><td>1.17±0.10</td><td>0.6 Max</td></tr><tr><td>RP10AT</td><td>1.20±0.10</td><td>1.20±0.10</td><td>0.6 Max</td></tr><tr><td>RN102</td><td>1.20±0.10</td><td>1.20±0.10</td><td>0.6 Max</td></tr><tr><td>RP104</td><td>1.20±0.10</td><td>2.20±0.10</td><td>0.6 Max</td></tr><tr><td>RN104</td><td>1.20±0.10</td><td>2.20±0.10</td><td>0.8 Max</td></tr></table> -0603: Press pocket.		A	B	T	0402	0.24±0.03	0.45±0.03	0.5 Max	0603	0.38±0.05	0.68±0.05	0.5 Max	1005	0.70±0.10	1.20±0.10	0.6 Max	RF062P	0.70±0.10	0.90±0.10	0.35 Max	RF064P	0.70±0.10	1.60±0.10	0.35 Max	RP102	1.17±0.10	1.17±0.10	0.6 Max	RP10AT	1.20±0.10	1.20±0.10	0.6 Max	RN102	1.20±0.10	1.20±0.10	0.6 Max	RP104	1.20±0.10	2.20±0.10	0.6 Max	RN104	1.20±0.10	2.20±0.10	0.8 Max
				A	B	T																																									
			0402	0.24±0.03	0.45±0.03	0.5 Max																																									
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RN104	1.20±0.10	2.20±0.10	0.8 Max																																												
Punched Paper	4mm		<table><tr><th></th><th>A</th><th>B</th><th>T</th></tr><tr><td>1608</td><td>1.10±0.20</td><td>1.90±0.20</td><td>0.8 Max</td></tr><tr><td>2012</td><td>1.65±0.20</td><td>2.40±0.20</td><td rowspan="4">1.1 Max</td></tr><tr><td>3216</td><td>2.00±0.20</td><td>3.60±0.20</td></tr><tr><td>3225</td><td>2.90±0.20</td><td>3.60±0.20</td></tr><tr><td>RP164</td><td>2.00±0.20</td><td>3.60±0.20</td></tr></table>		A	B	T	1608	1.10±0.20	1.90±0.20	0.8 Max	2012	1.65±0.20	2.40±0.20	1.1 Max	3216	2.00±0.20	3.60±0.20	3225	2.90±0.20	3.60±0.20	RP164	2.00±0.20	3.60±0.20																							
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			3216	2.00±0.20	3.60±0.20																																										
3225	2.90±0.20	3.60±0.20																																													
RP164	2.00±0.20	3.60±0.20																																													
Embossed Tape	12mm		<table><tr><th></th><th>A</th><th>B</th><th>T</th></tr><tr><td>5025</td><td>2.80±0.20</td><td>5.30±0.20</td><td rowspan="2">1.1 Max</td></tr><tr><td>6432</td><td>3.50±0.20</td><td>6.75±0.20</td></tr></table>		A	B	T	5025	2.80±0.20	5.30±0.20	1.1 Max	6432	3.50±0.20	6.75±0.20																																	
				A	B	T																																									
5025	2.80±0.20	5.30±0.20	1.1 Max																																												
6432	3.50±0.20	6.75±0.20																																													

Packaging Table

TYPE (mm)	TYPE (inch)	Taping Packaging				
		Code	Reels	Carrier Tape	Quantity	Weight(g)
0402	01005	CS	7"	Pressed Paper	20,000	143
0603	0201	CS	7"	Pressed Paper	15,000	126
		DP	7"	Punched PE	20,000	154
		AS	13"	Pressed Paper	60,000	573
		FP	13"	Punched PE	50,000	474
1005	0402	CS	7"	Punched paper	10,000	92
		DS	7"		20,000	152
		ES	10"		30,000	331
		AS	13"		40,000	539
1608	0603	CS	7"		5,000	125
		ES	10"		10,000	324
		AS	13"		20,000	561
		AS	13"		5,000	149
2012	0805	CS	7"		10,000	360
		ES	10"		20,000	658
		AS	13"		5,000	157
		AS	13"		10,000	382
3216	1206	CS	7"		20,000	695
		ES	10"		5,000	183
		AS	13"		10,000	463
		AS	13"		20,000	674
5025	2010	CS	7"	Embossed PE	4,000	202
6432	2512	CS	7"		4,000	267
		AS	13"		15,000	1,041
062P	0201×2R	CS	7"	Punched paper	20,000	126
064P	0201×4R	CS	7"		20,000	126
					10,000	100
102P	0402×2R	CS	7"		40,000	485
		AS	13"		10,000	136
104P	0402×4R	CS	7"		40,000	610
		AS	13"		5,000	157
164P	0603×4R	CS	7"	Punched paper	20,000	695
		AS	13"		10,000	100
10AT (1010)	0404	AS	13"		40,000	485

- General type, Precision, Low ohms, High ohms.
- Packaging style can be modified when you want.

Operation Notes

Example of land Pattern Design

Recommended Soldering Conditions

General Structure

General

Precision

Jumper

Low ohms (RUT Series)

Ultra Low ohms (RU Series)

Ultra Low Ohms (RUK Series)

Ultra Low Ohms (RJ Series)

Arrays (CONVEX Type)

Arrays (CONCAVE Type)

Arrays (FLAT Type)

Anti-Sulfur Resistors

Attenuator

Characteristics Performance

Packaging

Standard Resistance Value

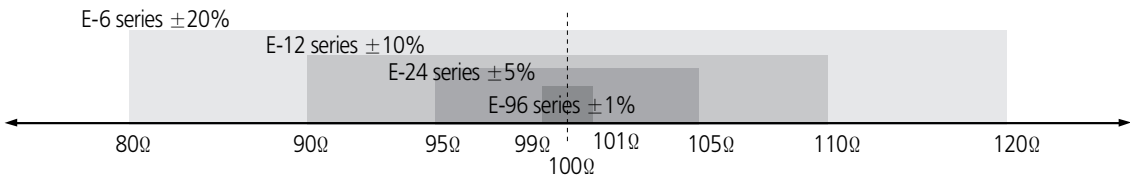
Tolerance Code Table

Tolerance Code	D	F	G	J	K	M
Digit Number	4 digit			3 digit		
IEC-Code System	E-192	E-96	E-48	E-24	E-12	E-6
Specification	±0.5%	±1%	±2%	±5%	±10%	±20%

Significant Figure of Resistance Value

E-192	E-96	E-48	E-24	E-192	E-96	E-48	E-24	E-192	E-96	E-48	E-24	E-192	E-96	E-48	E-24
100	100	100	10	178	178	178	18	316	316	316		562	562	562	56
101	102			180	182			320	324			569	576		
102				182				324				576			
104				184				328				583			
105	105	105		187	187	187		332	332	332	33	590	590	590	
106	107			189	191			336	340			597	604		
107				191				340				604			
109				193				344				612			
110	110	110	11	196	196	196	20	348	348	348		619	619	619	62
111	113			198	200			352	357			626	634		
113				200				357				634			
114				203				361				642			
115	115	115		205	205	205		365	365	365	36	649	649	649	
117	118			208	210			370	374			657	665		
118				210				374				665			
120				213				379				673			
121	121	121	12	215	215	215	22	383	383	383		681	681	681	68
123	124			218	221			388	392			690	698		
124				221				392				698			
126				223				397				706			
127	127	127		226	226	226		402	402	402		715	715	715	
129	130			229	232			407	412			723	732		
130				232				412				732			
132				234				417				741			
133	133	133		237	237	237	24	422	422	422		750	750	750	75
135	137			240	243			427	432			759	768		
137				243				432				768			
138				246				437				777			
140	140	140		249	249	249		442	442	442		787	787	787	
142	143			252	255			448	453			796	806		
143				255				453				806			
145				258				459				816			
147	147	147		261	261	261		464	464	464		825	825	825	82
149	150			264	267			470	475			835	845		
150				267				475				845			
152				271				481				856			
154	154	154		274	274	274	27	487	487	487		866	866	866	
156	158			277	280			493	499			876	887		
158				280				499				887			
160				284				505				898			
162	162	162	16	287	287	287		511	511	511	51	909	909	909	91
164	165			291	294			517	523			920	931		
165				294				523				931			
167				298				530				942			
169	169	169		301	301	301	30	536	536	536		953	953	953	
172	174			305	309			542	549			965	976		
174				309				549				976			
176				312				556				988			

• Example



Operation
Notes

Example of land
Pattern Design

Recommended
Soldering Conditions

General Structure

General

Precision

Jumper

Low ohms
(RUT Series)

Ultra Low ohms
(RU Series)

Ultra Low Ohms
(RUK Series)

Ultra Low Ohms
(RJ Series)

Arrays
(CONVEX Type)

Arrays
(CONCAVE Type)

Arrays
(FLAT Type)

Anti-Sulfur
Resistors

Attenuator

Characteristics
Performance

Packaging

Standard
Resistance Value

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 - ③ Medical equipment
 - ④ Military equipment
 - ⑤ Disaster prevention/crime prevention equipment
 - ⑥ Any other applications with the same as or similar complexity or reliability to the applications set forth above.



Quality System Certification List

Table 1: Certification list of Samsung Factory

Certification	Section	High Tech(China)
ISO / TS 16949	Authority	BSI
	Number	TS 91430-008
	Date	2011 - 11 - 29
	Validity	2014 - 11 - 28
ISO 14001	Authority	BSI
	Number	EMS 585307
	Date	2012 - 04 - 17
	Validity	2015 - 04 - 16
OHSAS 18001	Authority	BSI
	Number	OHS 585308
	Date	2012 - 04 - 17
	Validity	2015 - 04 - 16
QC080000	Authority	UL
	Number	PRC-HSPM-1766
	Date	2010 - 07 - 27
	Validity	2013 - 07 - 26

Operation
Notes

Example of land
Pattern Design

Recommended
Soldering Conditions

General Structure

General

Precision

Jumper

Low ohms
(RUT Series)

Ultra Low ohms
(RU Series)

Ultra Low Ohms
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Ultra Low Ohms
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Arrays
(CONVEX Type)

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Arrays
(FLAT Type)

Anti-Sulfur
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Resistance Value